

EVB Schematic For PX30

Version: RK_EVB_PX30_DDR3P216SD4_V10

PMIC: RK809-1 (5BUCK + 9LDO + Codec)
RAM: DDR3
ROM: eMMC/Nand + TF card
Interface: MIPICSI/MIPIDSI/UART/I2S/RMII

Rockchip Confidential

 瑞芯微电子		Fuzhou Rockchip Electronics		
Project:	PX30			
File:	00.Cover Page			
Date:	Thursday, January 11, 2016		Rev:	V0.1
Designed by:	XIAOHF		Sheet:	1 of 35

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Note

NOTE 1:

Component parameter description

1. DNP stands for component not mounted temporarily
2. If Value or option is DNP, which means the area is reserved without being mounted
3. If Flash is compatible, please notice when eMMC is used, the option is that @eMMC is mounted, @Nand is not mounted when Nand is used, the option is that @Nand is mounted, @eMMC is not mounted

NOTE 2:

Please use our recommended components to avoid too many changes.For more informations about the second source,please refer to our AVL.

Note				
Option				
Description				
Remind				

Bill of Materials

Header:

Item\tPart\tDescription\tPCB Footprint\tReference\tQuantity\tOption

Combined property string:

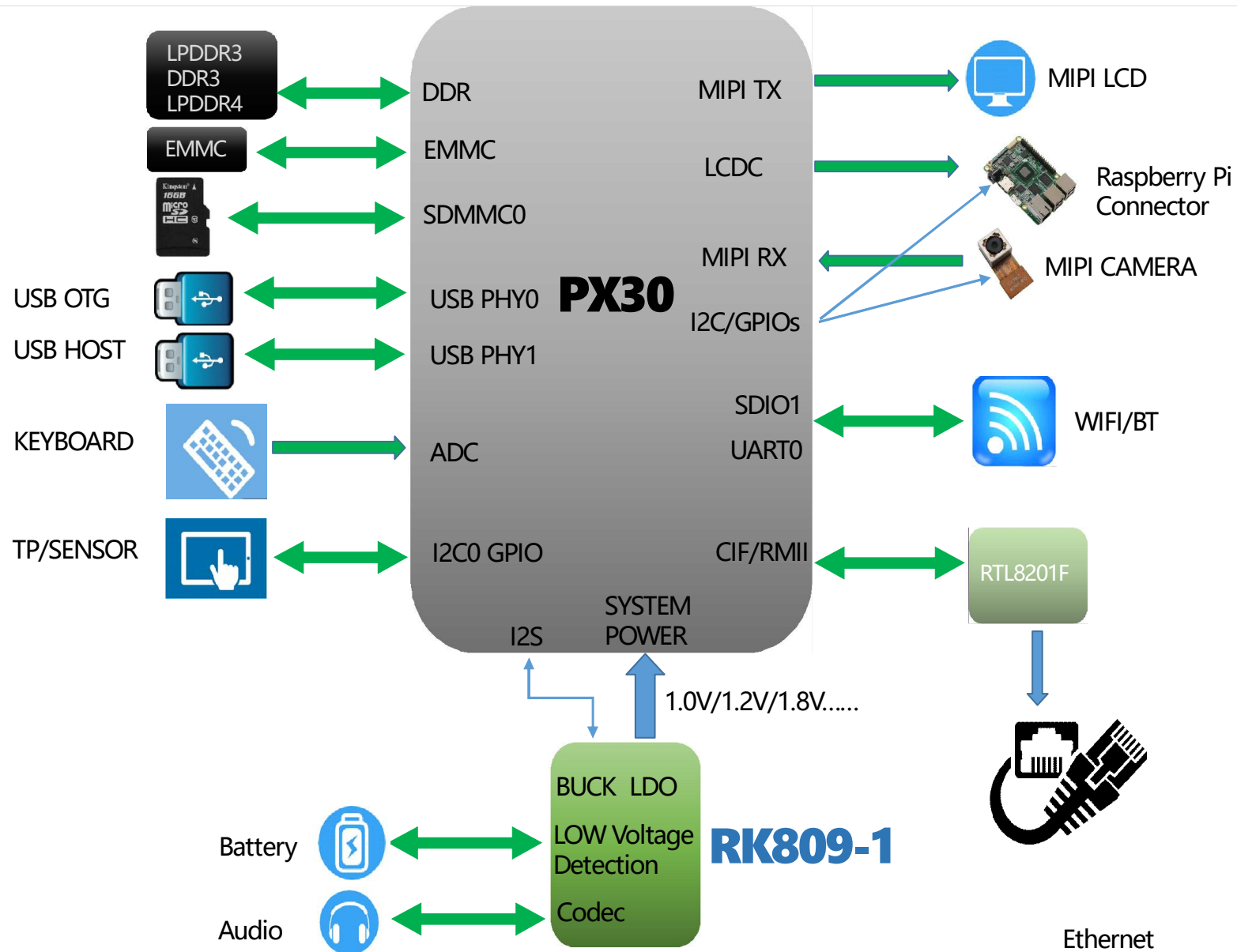
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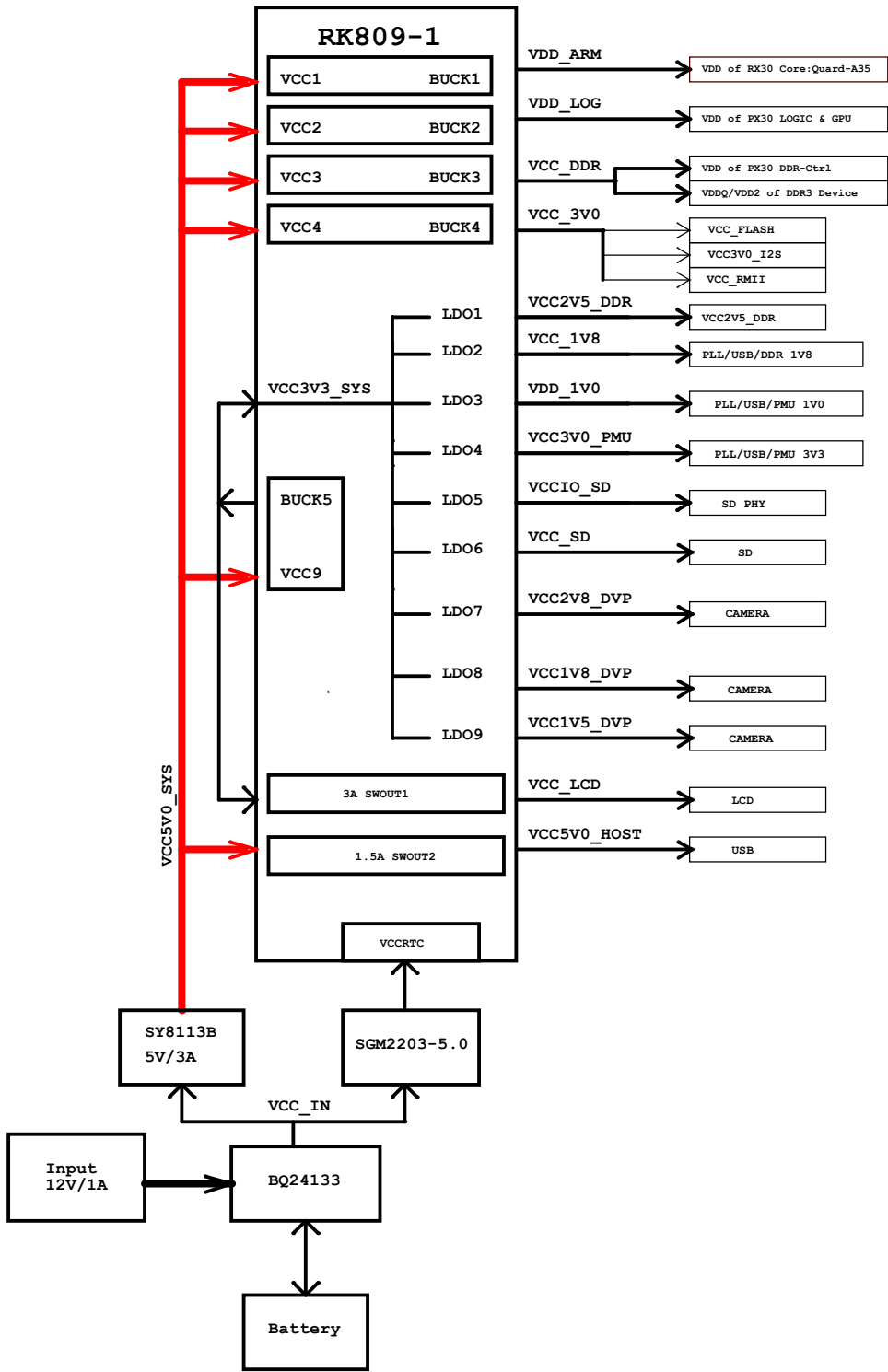
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Project:	PX30		
File:	01.Index		
Date:	Thursday, January 11, 2018	Rev:	V0.1
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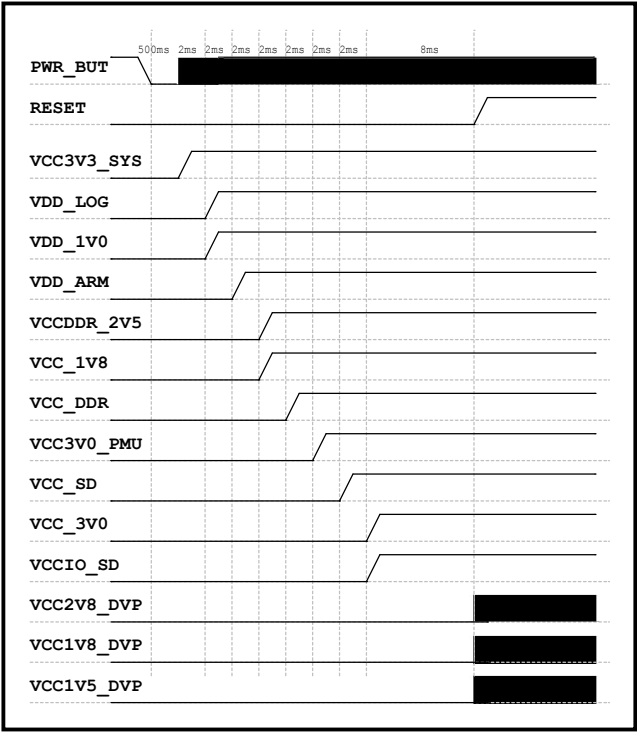
Version	Date	Author	Change List	Approved
V0.1	20171227	XHF	First edition for PX30	



POWER DIAGRAM




RK809-1 Power-on Sequence							
PowerName	PMIC Channel	Time Slot (step 2mS)	Default voltage	Supply Limit	Default ON/OFF	Sleep ON/OFF	Peak Current
VDD_ARM	BUCK1	Slot:13	1.0V	2.5A	ON	OFF	1.5A
VDD_LOG	BUCK2	Slot:12	1.0V	2.5A	ON		1.4A
VCC_DDR	BUCK3	Slot:15	FB=0.6V	1.5A	ON	ON	1.5A
VCC_3V0	BUCK4	Slot:18	3.0V	1.5A	ON	ON	1.5A
VCC3V3_SYS	BUCK5	Slot:11	3.3V	1.5A	ON	ON	
VCCDDR_2V5	LDO1	Slot:14	2.5V	500mA	ON	ON	
VCC_1V8	LDO2	Slot:14	1.8V	500mA	ON	ON	
VDD_1V0	LDO3	Slot:12	1.0V	500mA	ON	ON	
VCC3V0_PMU	LDO4	Slot:16	3.0V	100mA	ON	ON	12mA
VCCIO_SD	LDO5	Slot:18	3.0V	500mA	ON		
VCC_SD	LDO6	Slot:17	3.0V	500mA	ON		400mA
VCC2V8_DVP	LDO7		2.8V	500mA	OFF	OFF	
VCC1V8_DVP	LDO8		1.8V	500mA	OFF	OFF	
VCC1V5_DVP	LDO9		1.5V	500mA	OFF	OFF	
RESET	RESETB	Slot:11	OD				



I2C MAP

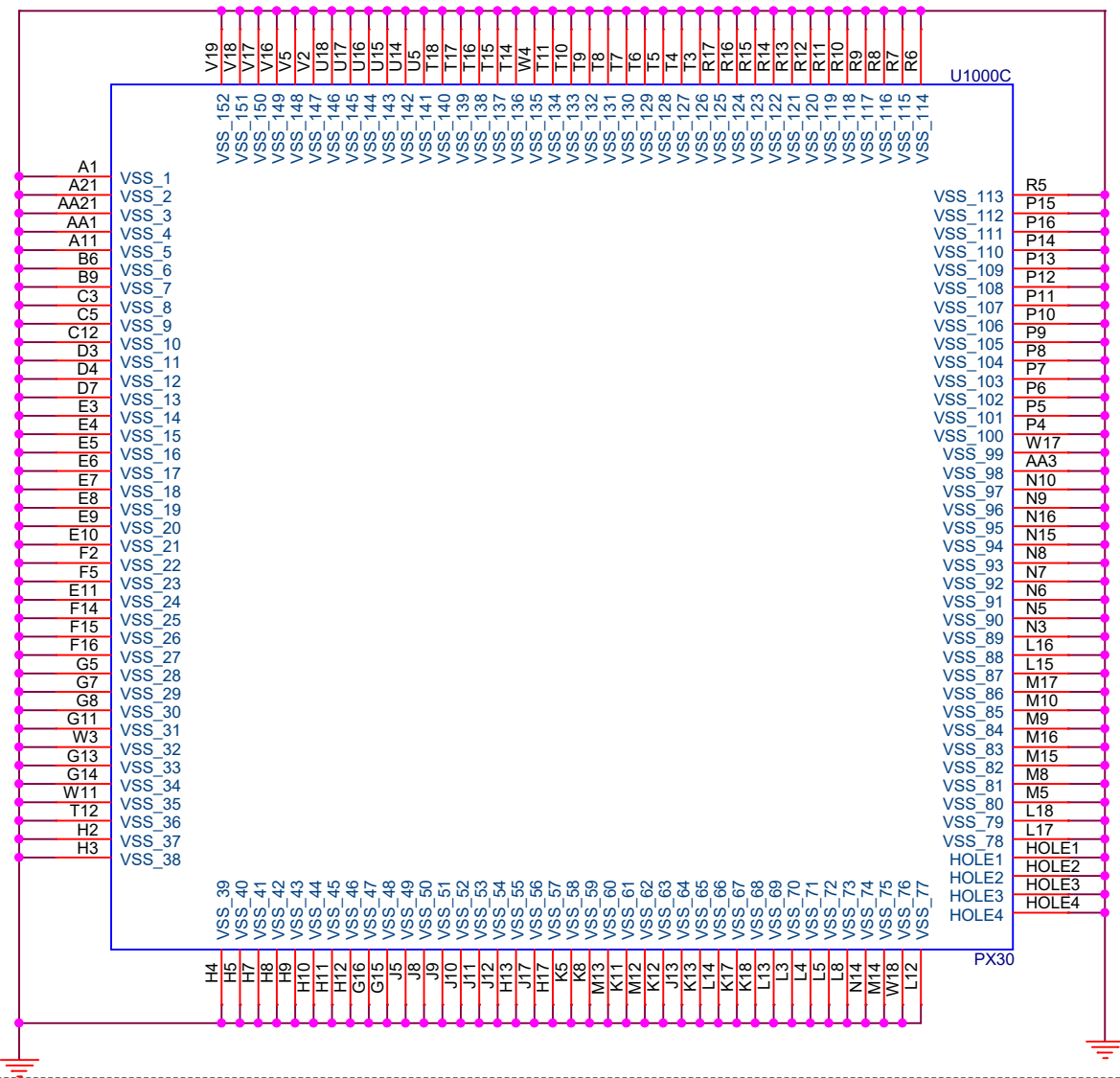
Port	Pin name	Domain	Bus name	Pull-up voltage	Slave Device	Slave Addr (MS 7Bits)	Note	Slave Bus Capability
I2C0	I2C0_SDA/GPIO0_B1_u I2C0_SCL/GPIO0_B0_u	PMUIO2	I2C0_SDA I2C0_SDA	VCC3V0_PMU			Sensor	
							Touch IC	
							Raspberry Pi	
I2C1	I2C1_SDA/GPIO0_C3_u I2C1_SCL/PMU_DEBUG5/GPIO0_C2_u	PMUIO2	I2C_SDA_PMIC I2C_SCL_PMIC	VCC3V0_PMU	Rockchip RK809-1		PMIC	
I2C2	I2C2_SDA/GPIO2_C0_u I2C2_SCL/GPIO2_B7_u	VCCIO3	I2C2_SDA_CAM I2C2_SCL_CAM	VCC_RMII			MIPI Camera	
							Raspberry Pi	



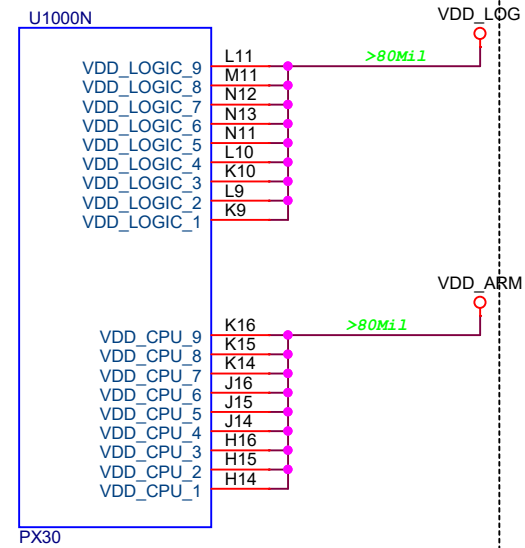
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Project:	PX30		
File:	04.I2C MAP		
Date:	Thursday, January 11, 2018	Rev:	V0.1
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Part C GND

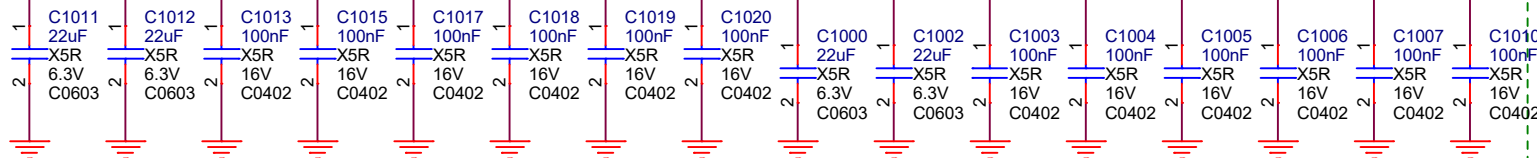


Part N Power



VDD_LOG

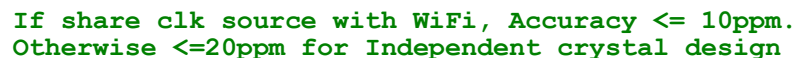
VDD_ARM



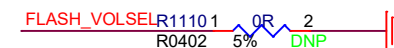
Place these decoupling capacitances close to the SOC power supply balls

<div><div>瑞芯微电子</div></div>		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	10.PX30 Power		
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Part I

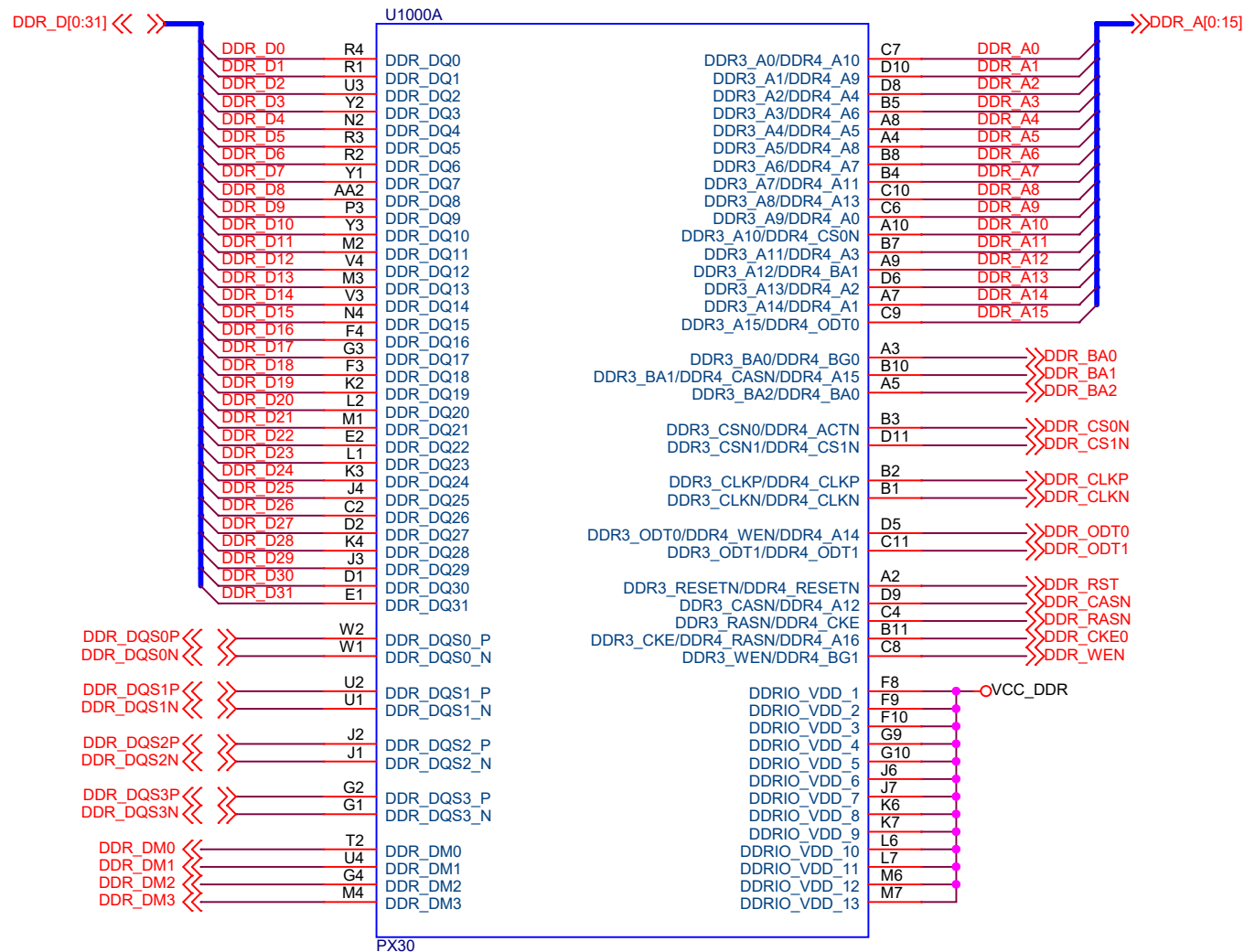


Part J



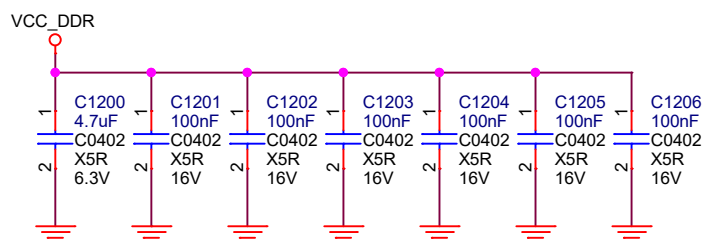
VCCIO_FLASH	VCCIO_FLASH=1.8V	VCCIO_FLASH=3.3V
R1110	OR	DNP

Part A DDR Controller



DDR3/DDR4 PIN MUX

DDR3_A0	DDR4_A10
DDR3_A1	DDR4_A9
DDR3_A2	DDR4_A4
DDR3_A3	DDR4_A6
DDR3_A4	DDR4_A5
DDR3_A5	DDR4_A8
DDR3_A6	DDR4_A7
DDR3_A7	DDR4_A11
DDR3_A8	DDR4_A13
DDR3_A9	DDR4_A0
DDR3_A10	DDR4_CS0n
DDR3_A11	DDR4_A3
DDR3_A12	DDR4_BA1
DDR3_A13	DDR4_A2
DDR3_A14	DDR4_A1
DDR3_A15	DDR4_ODT0
DDR3_BA0	DDR4_BG0
DDR3_BA1	DDR4_CASn/DDR4_A15
DDR3_BA2	DDR4_BA0
DDR3_CS0N	DDR4_ACTn
DDR3_CS1N	DDR4_CS1N
DDR3_ODT0	DDR4_WEn/DDR4_A14
DDR3_ODT1	DDR4_ODT1
DDR3_CLKP	DDR4_CLKP
DDR3_CLKn	DDR4_CLKn
DDR3_CKE	DDR4_RASn/DDR4_A16
DDR3_RASn	DDR4_CKE
DDR3_CASN	DDR4_A12
DDR3_WEn	DDR4_BG1
DDR3_RST	DDR4_RST



Place these decoupling capacitances close to the SOC power supply balls

Part L

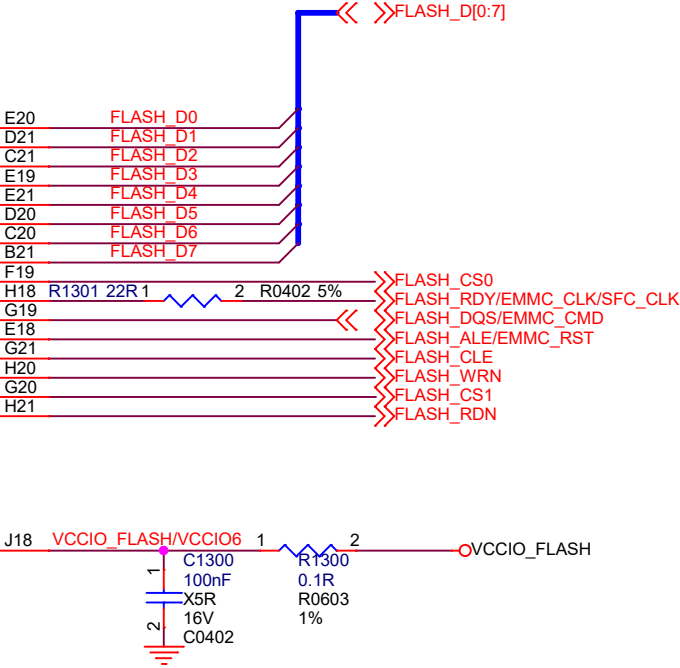
U1000L


FLASH_D0/EMMC_D0/SFC_SIO0/GPIO1_A0_u
FLASH_D1/EMMC_D1/SFC_SIO1/GPIO1_A1_u
FLASH_D2/EMMC_D2/SFC_SIO2/GPIO1_A2_u
FLASH_D3/EMMC_D3/SFC_SIO3/GPIO1_A3_u
FLASH_D4/EMMC_D4/SFC_CSN0/GPIO1_A4_u
FLASH_D5/EMMC_D5/GPIO1_A5_u
FLASH_D6/EMMC_D6/GPIO1_A6_u
FLASH_D7/EMMC_D7/GPIO1_A7_u
FLASH_CS0/GPIO1_B0_u
FLASH_RDY/EMMC_CLKOUT/SFC_CLK/GPIO1_B1_u
FLASH_DQS/EMMC_CMD/GPIO1_B2_u
FLASH_ALE/EMMC_RSTN/GPIO1_B3_d
FLASH_CLE/UART3_CTS_M1/SPI0_TXD/I2C3_SDA/GPIO1_B4_d
FLASH_WRN/UART3_RTS_M1/SPI0_RXD/I2C3_SCL/GPIO1_B5_u
FLASH_CS1/UART3_TX_M1/SPI0_CSN/GPIO1_B6_u
FLASH_RDN/UART3_RX_M1/SPI0_CLK/GPIO1_B7_u

VCCIO6

PX30

FLASH



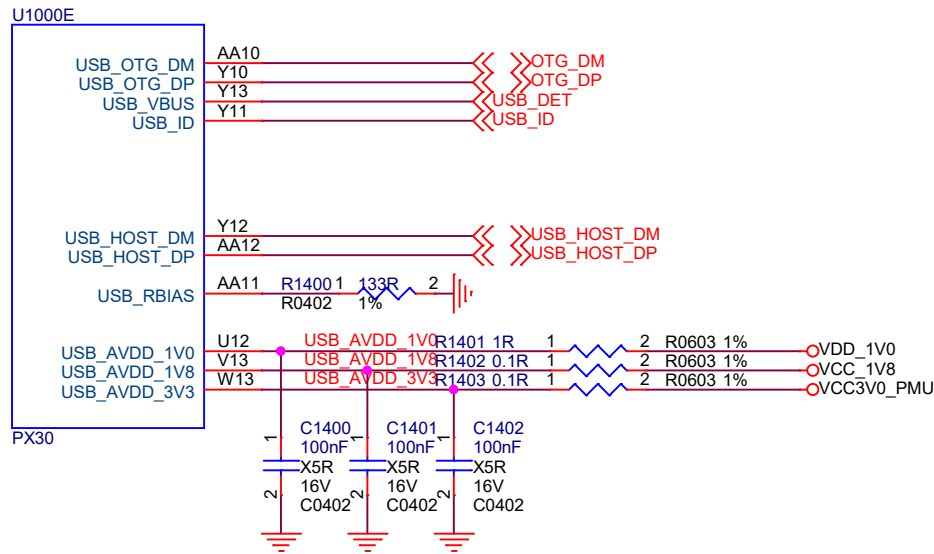



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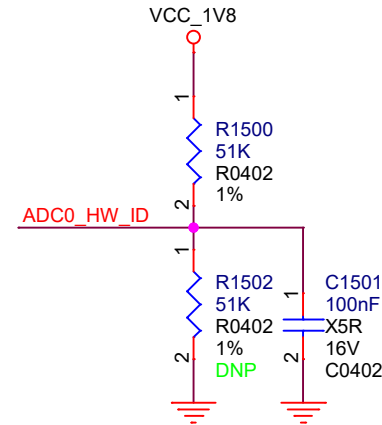
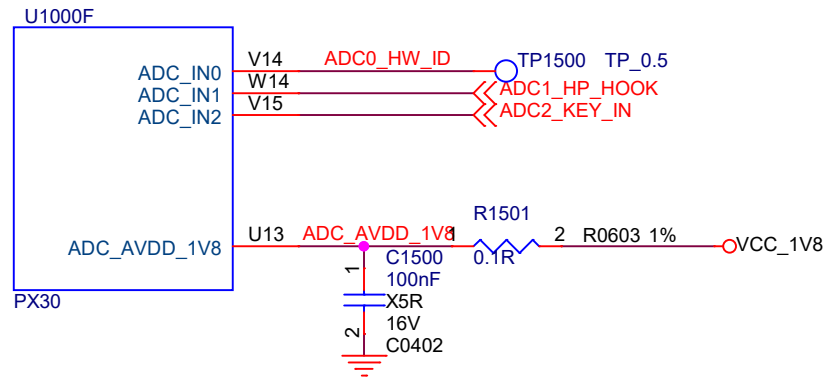
Project:	PX30		
File:	13.PX30 Flash Controller		
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Part E




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Project:	PX30		
File:	14.PX30 USB Controller		
Date:	Thursday, January 11, 2018	Rev:	V0.1
Designed by:	XIAOHF	Sheet:	11 of 35

Part F

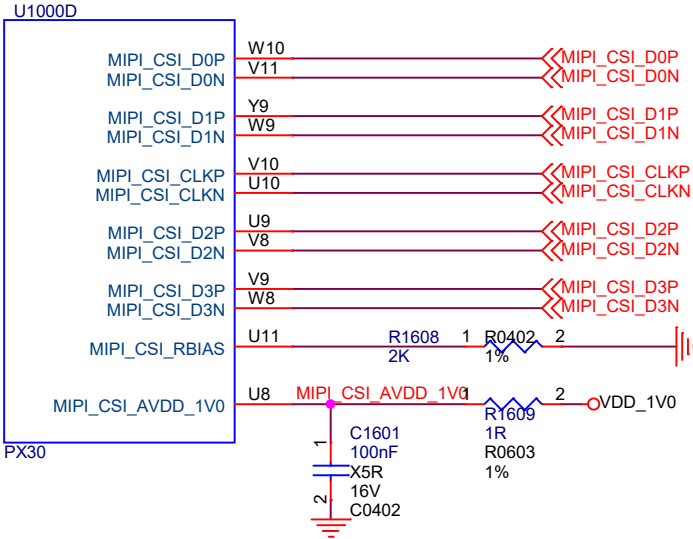


HW ID

ADC0_HW_ID		Up Resistance	Down Resistance	
Reserve		DNP	51K	
		110K	51K	
		100K	51K	
		100K	33K	
		36K	18K	
		51K	36K	
		51K	51K	
		36K	51K	
		18K	36K	
		33K	100K	
		20K	100K	
		10K	110K	
		10K	DNP	

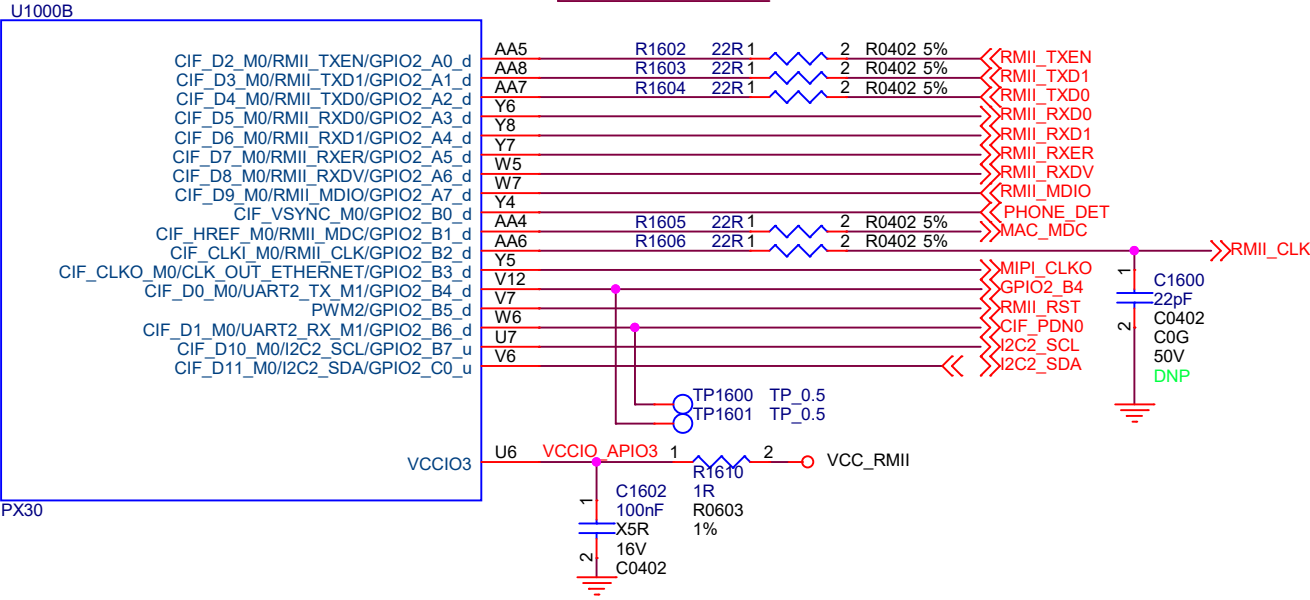
 瑞芯微电子		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	15.PX30 ADC		
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Part D



MIPI CSI

Part B



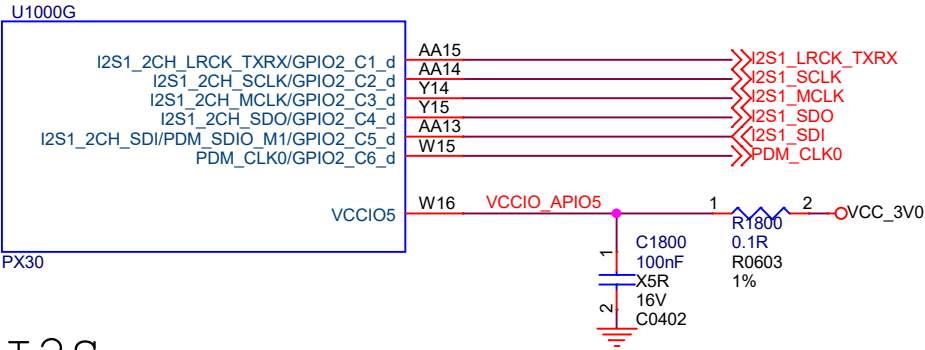
CIF/RMII

Part M

U1000M

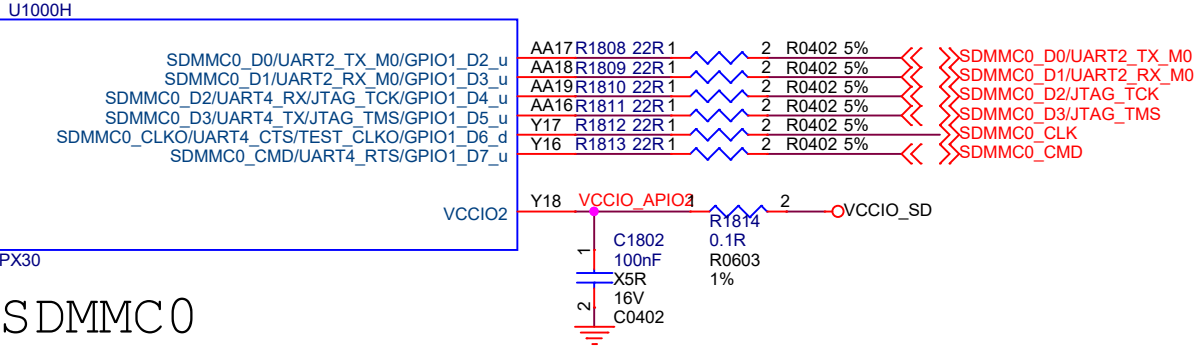


Part G



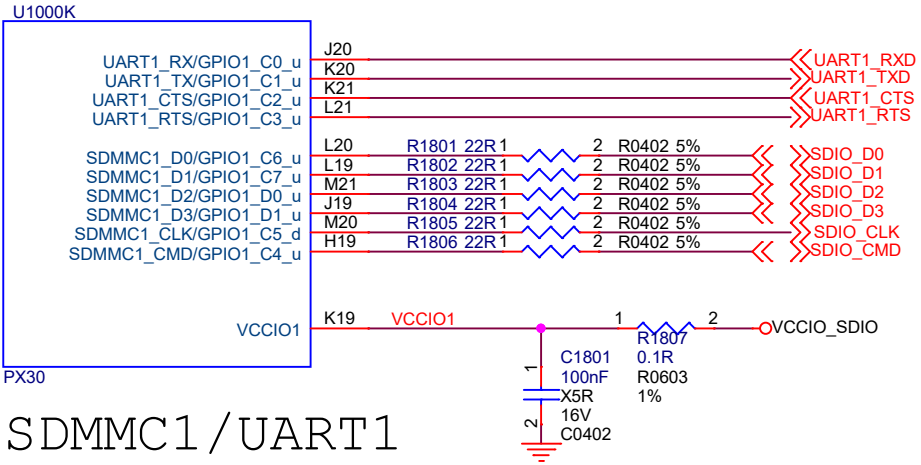
I2S

Part H



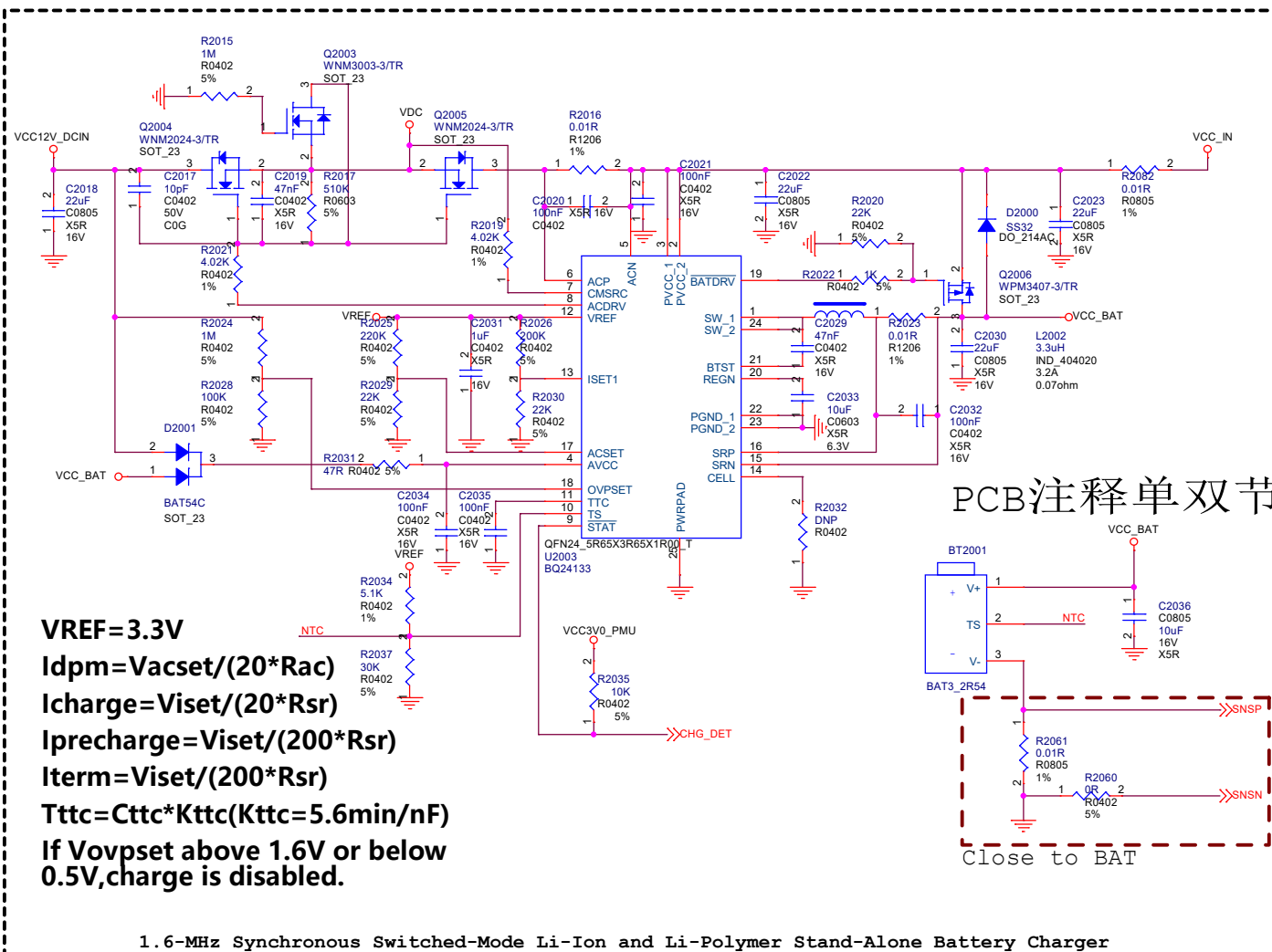
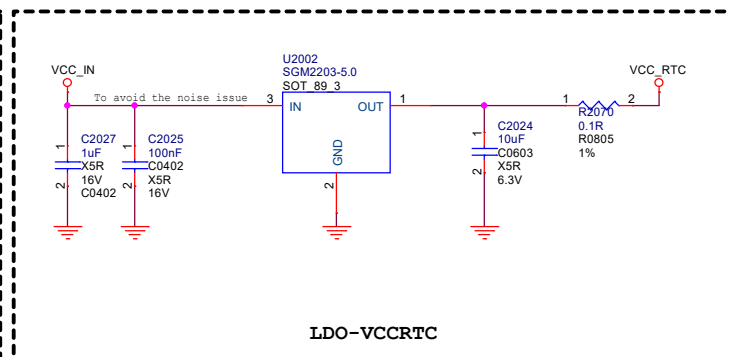
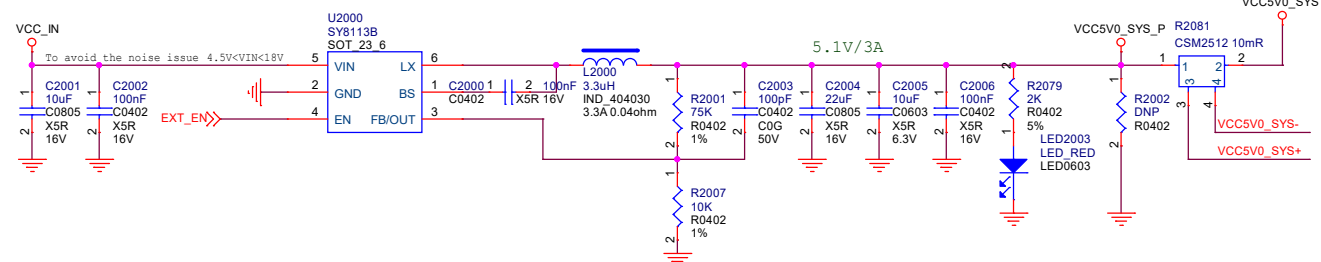
SDMMC0


Part K



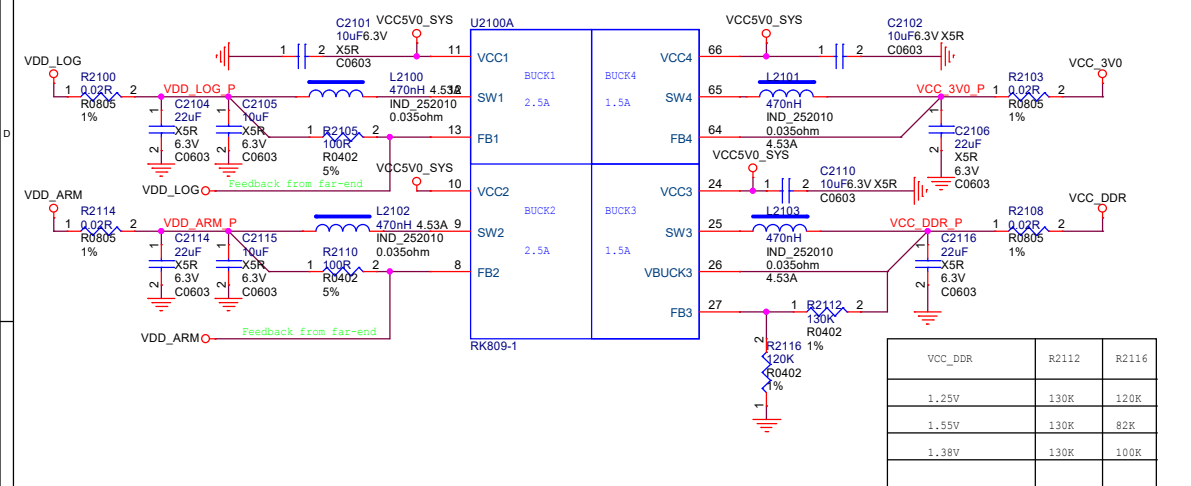
SDMMC1 / UART1

The schematic diagram illustrates the DC-DC converter circuit. It features a 12V DCIN input connected to a J2000 DC-0007-5P connector. The output of the converter is VCC12V_DCIN. The circuit includes a switch S2001 (KCD1-11-3P-W) and several passive components: a 100R resistor (R2090, 5%, R0805), a 2R resistor (R2050, 5%, R0805), a 1210 resistor (R1210, 5%, R0805), a 2.2uF capacitor (C2051, X5R, 25V, C0805), and a 10uF capacitor (C205, X5R, 16V, C0805). The circuit is powered by a 12V DCIN input and includes a 100R resistor (R2090, 5%, R0805) and a 2.2uF capacitor (C2051, X5R, 25V, C0805) for filtering. The output is VCC12V_DCIN.

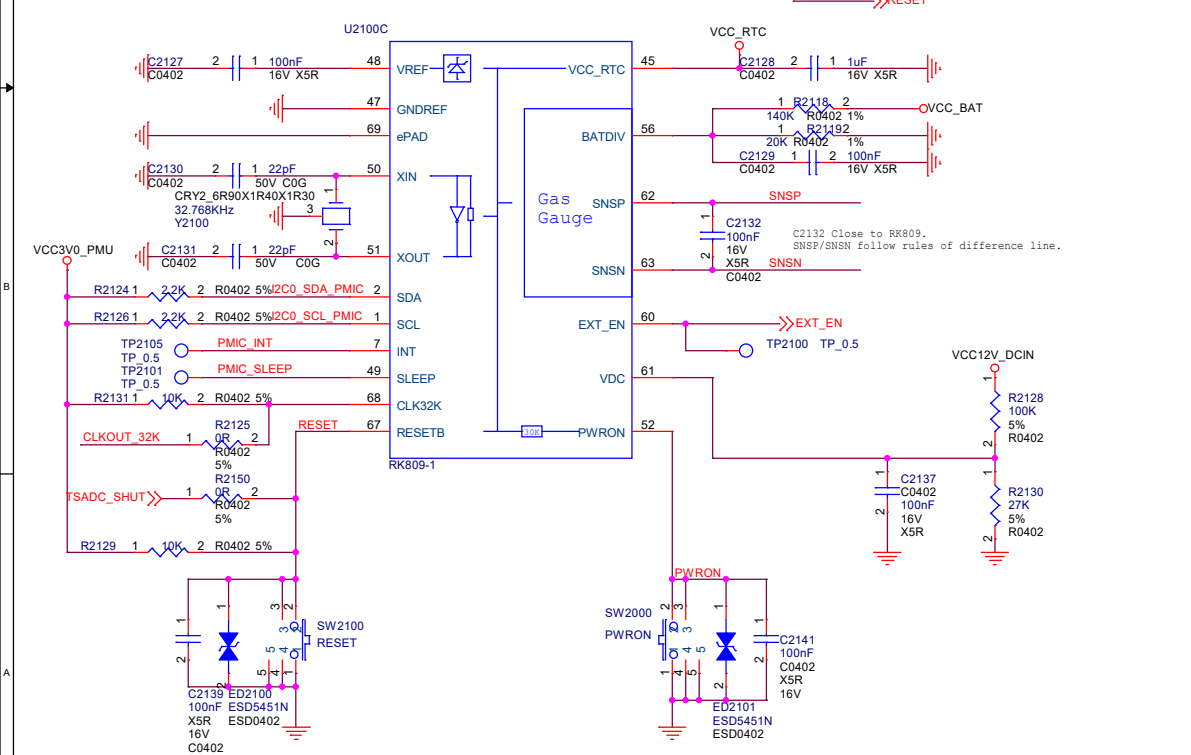


 瑞芯微电子		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	20.Power-DC IN		
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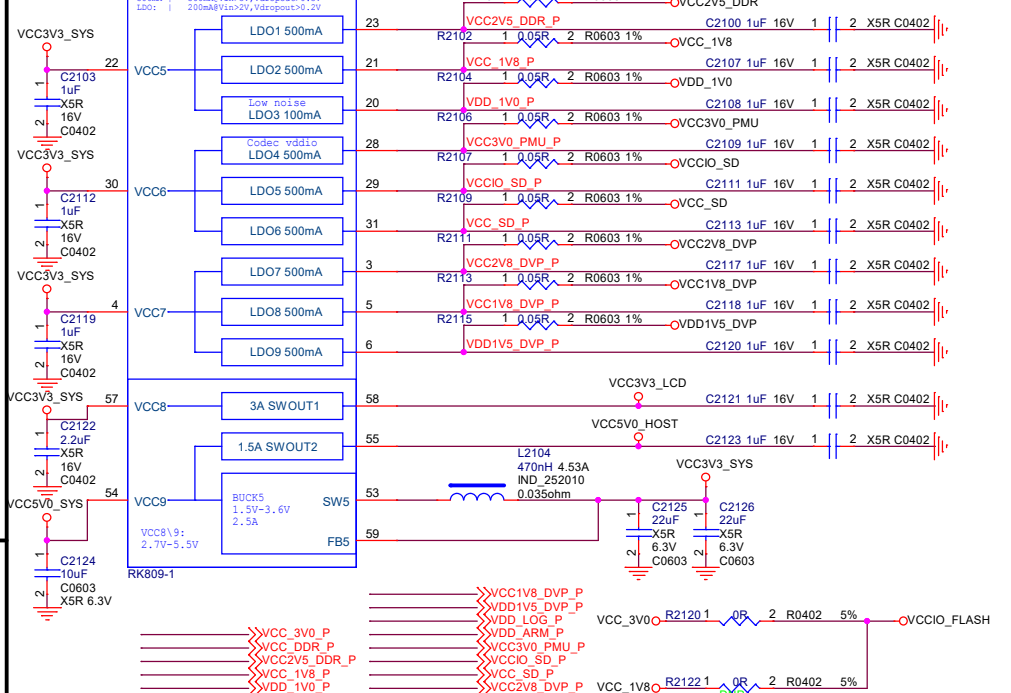
PMIC RK809-1 DCDC



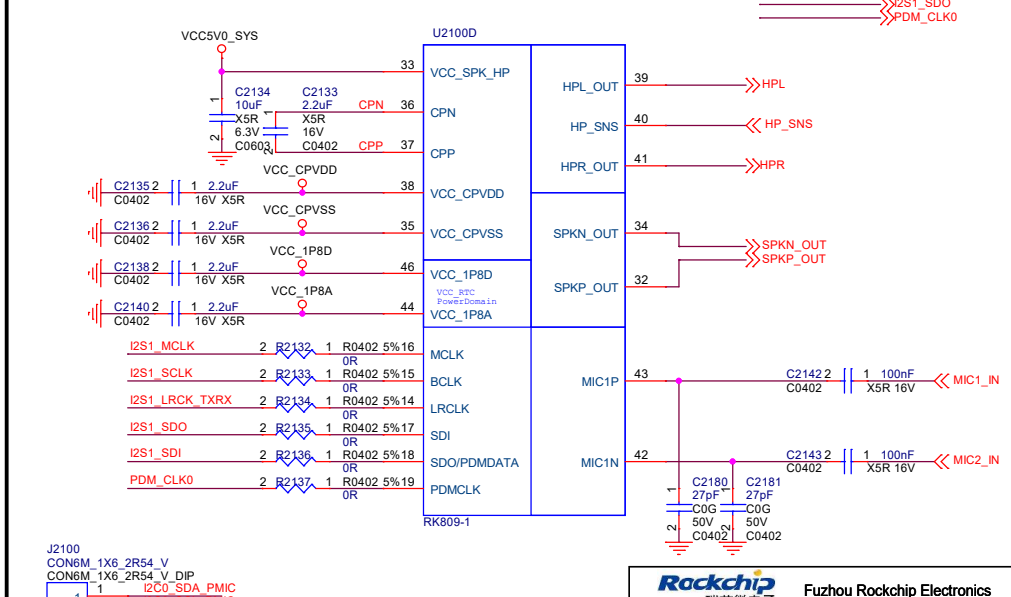
PMIC RK809-1 Managerment



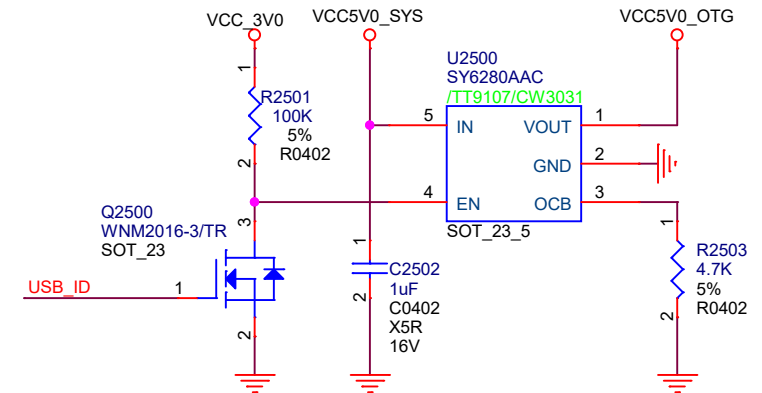
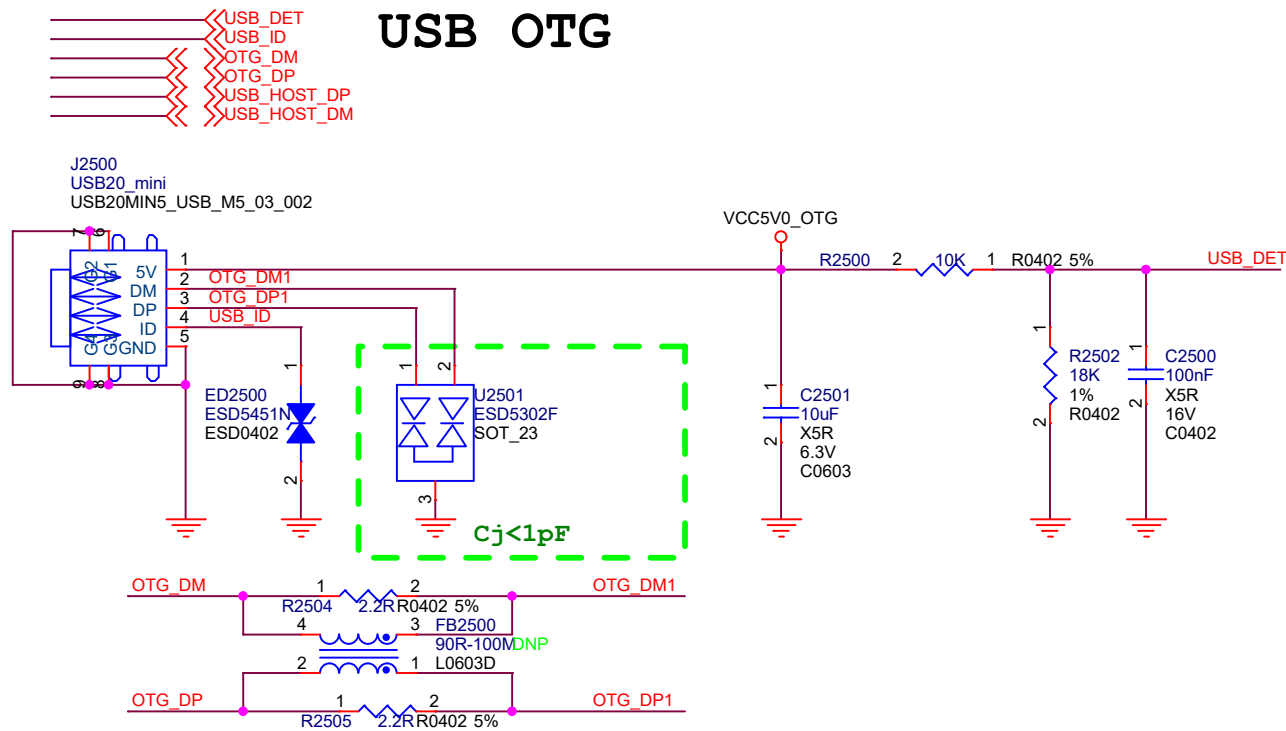
PMIC RK809-1 LDO



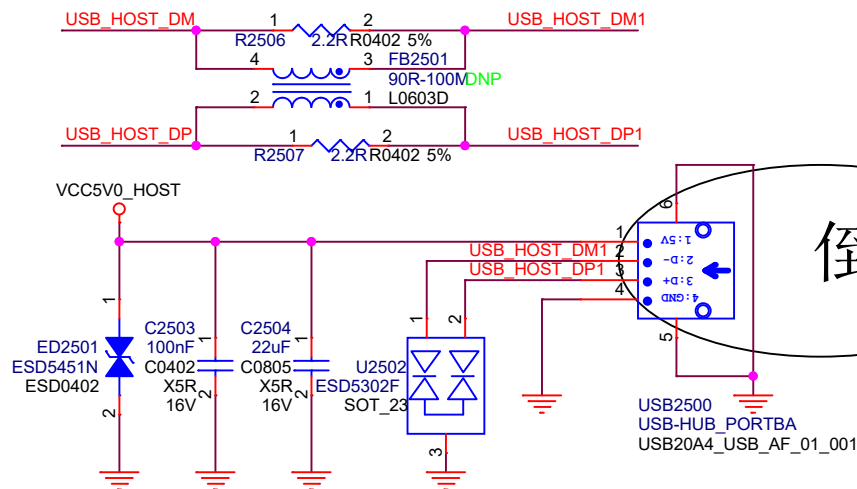
PMIC RK809-1 CODEC



USB OTG



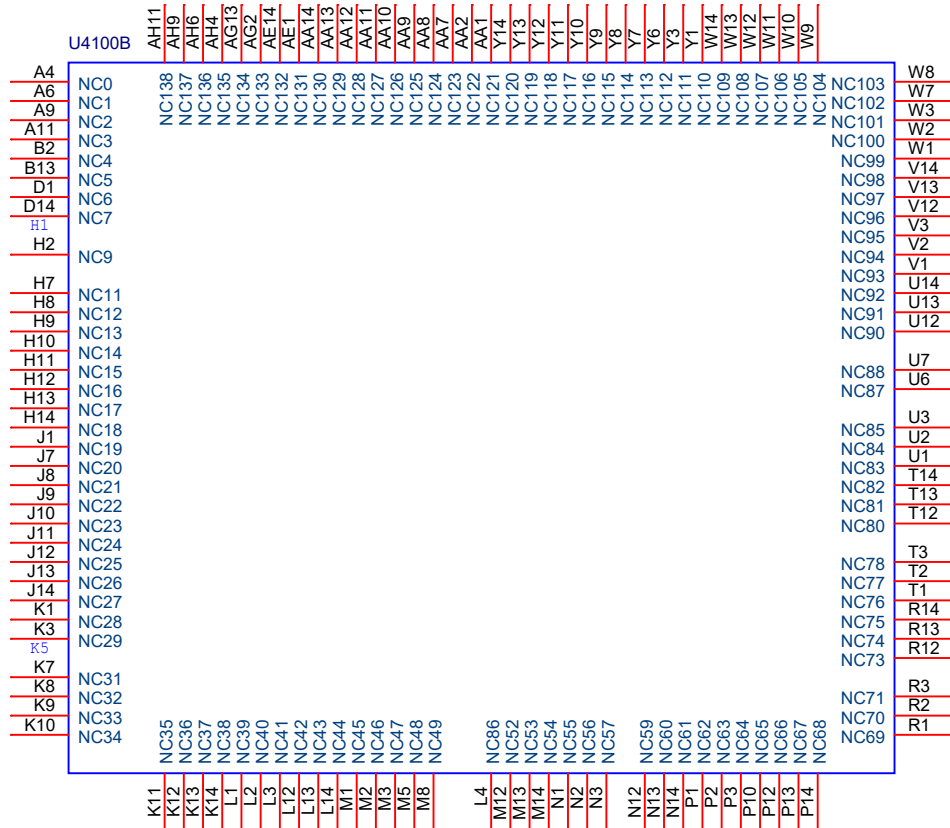
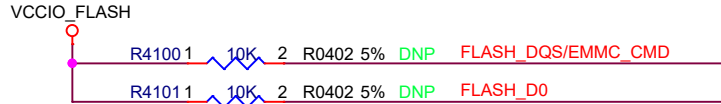
USB HOST



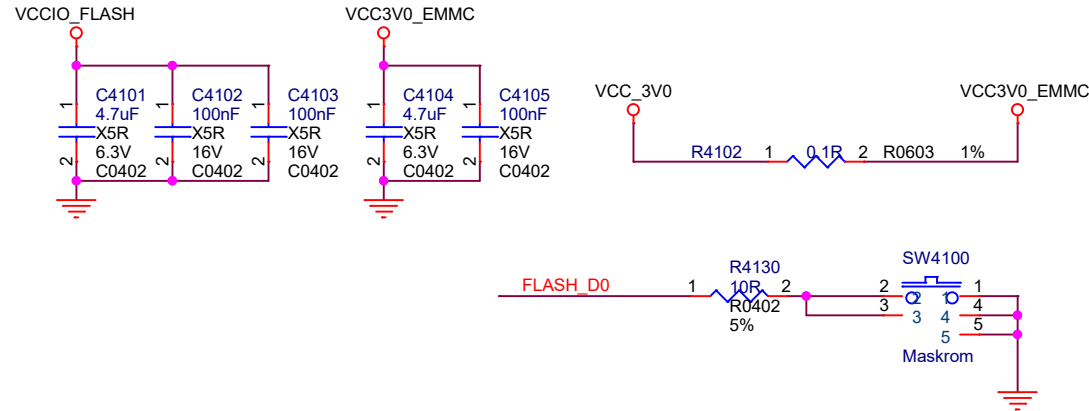
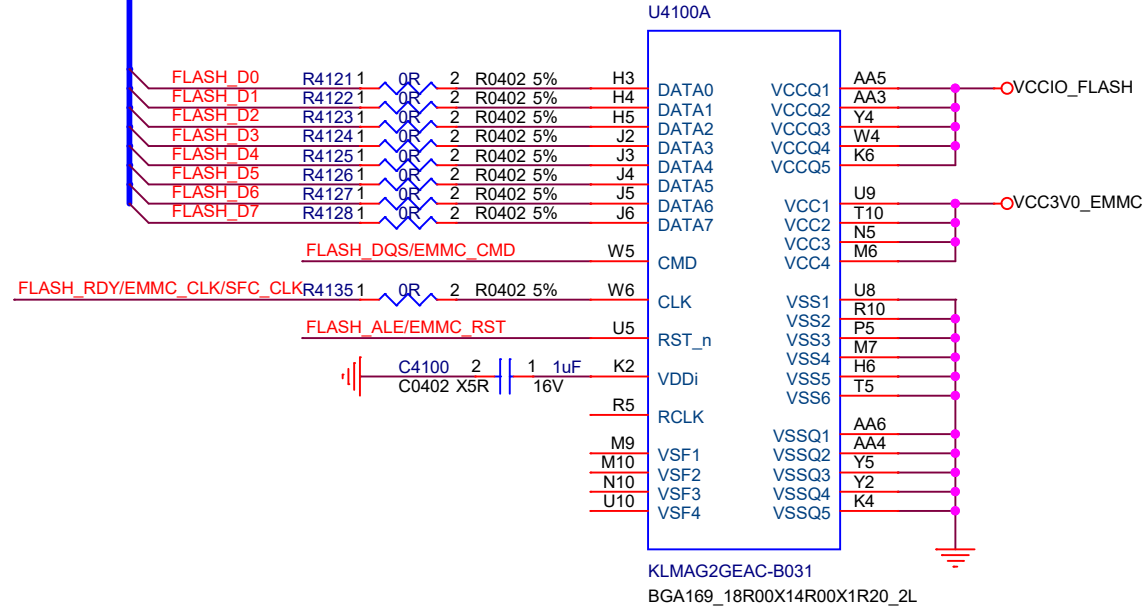
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 瑞芯微电子		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	25.USB OTG/HOST		
Date:	Thursday, January 11, 2018	Rev:	V0.1
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eMMC




FLASH_D[0:7] << >>



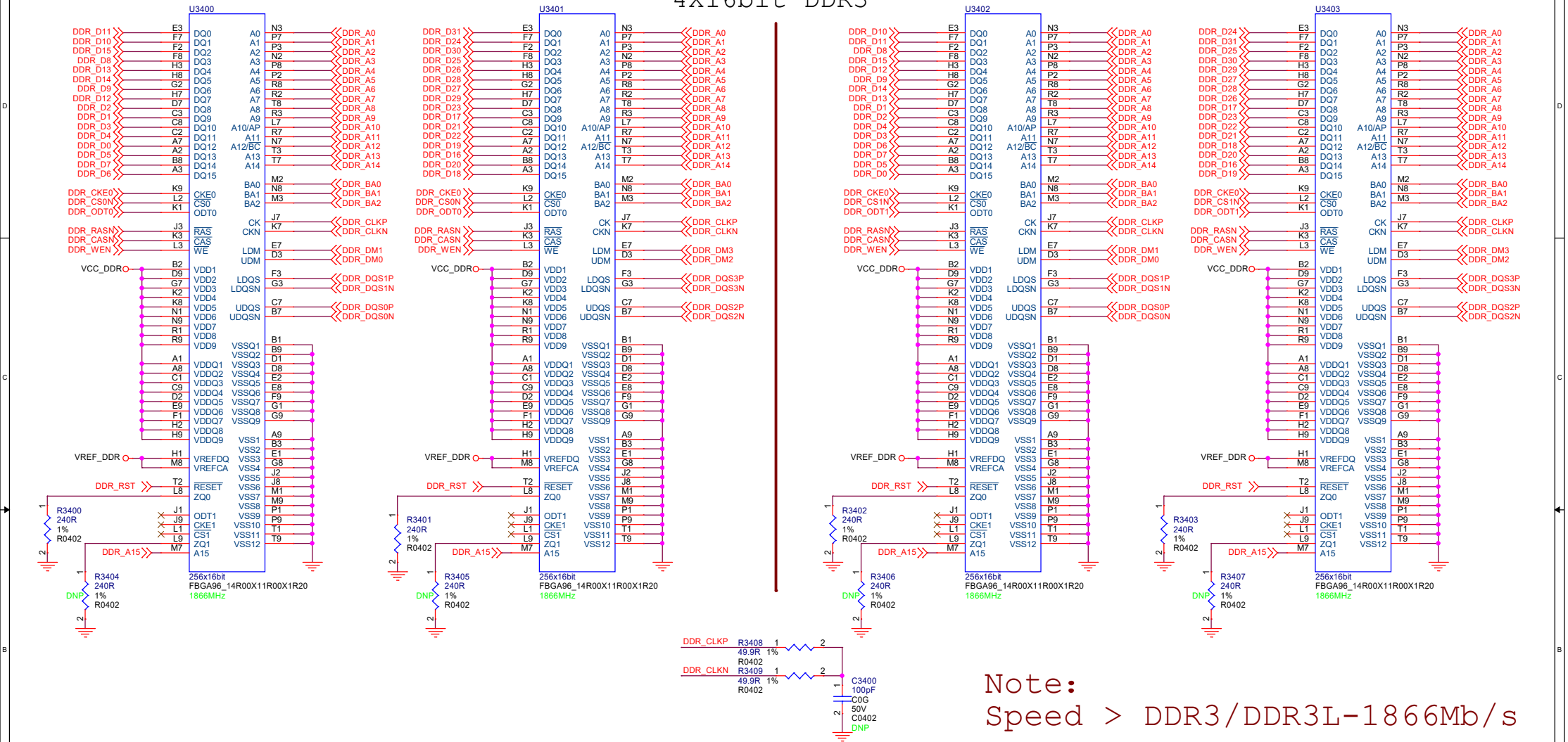
Note:
Short two TP points to Enter Maskrom Mode.

BGA169_18R00X14R00X1R20_2L
KLMAG2GEAC-B031

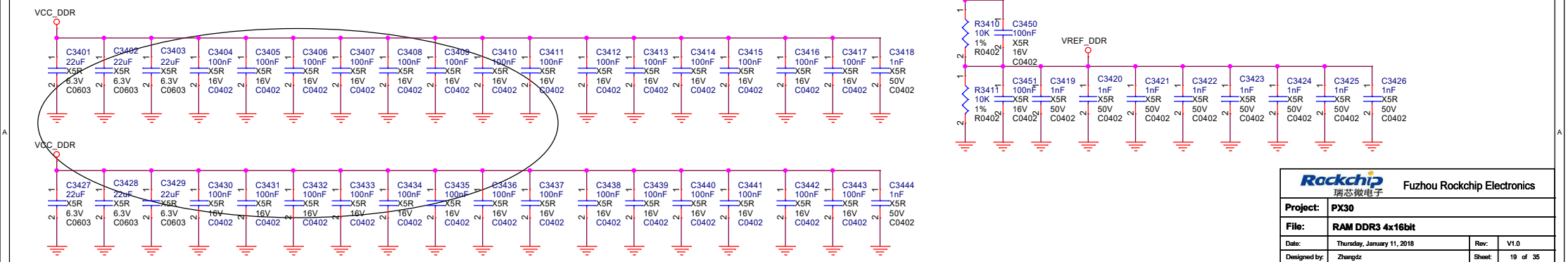
Remind: Refer to the latest AVL for parts selection.

<div> 瑞芯微电子</div>		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	41.Flash-EMMC		
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4X16bit DDR3

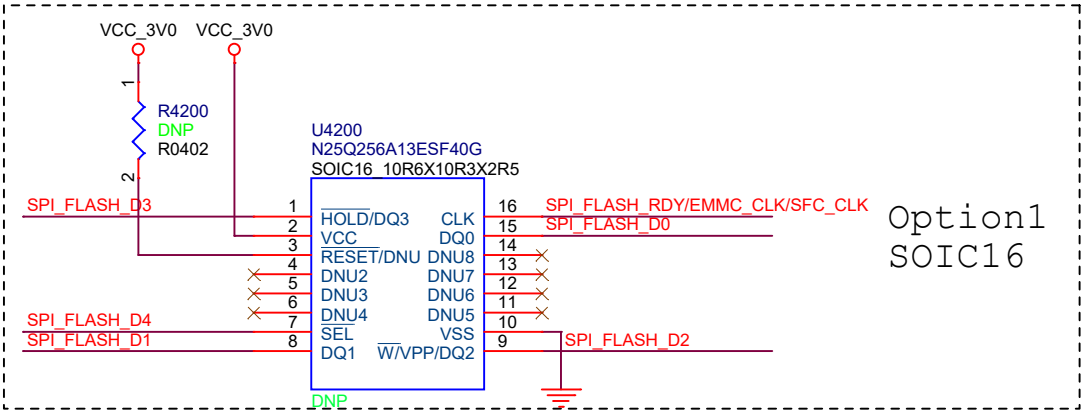
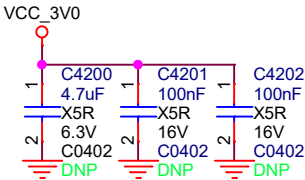
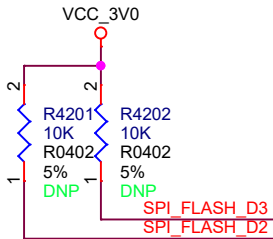
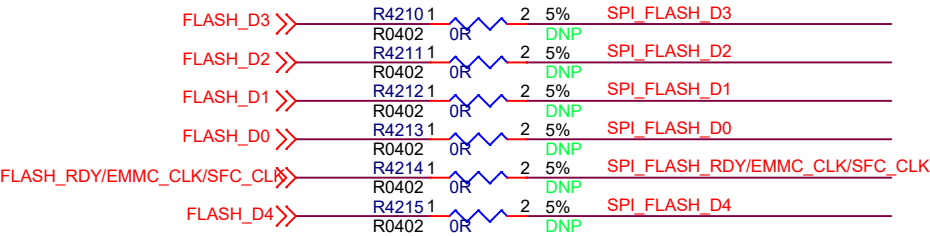


DDR3 FILTER




SPI Flash

Reserved for minimal system.

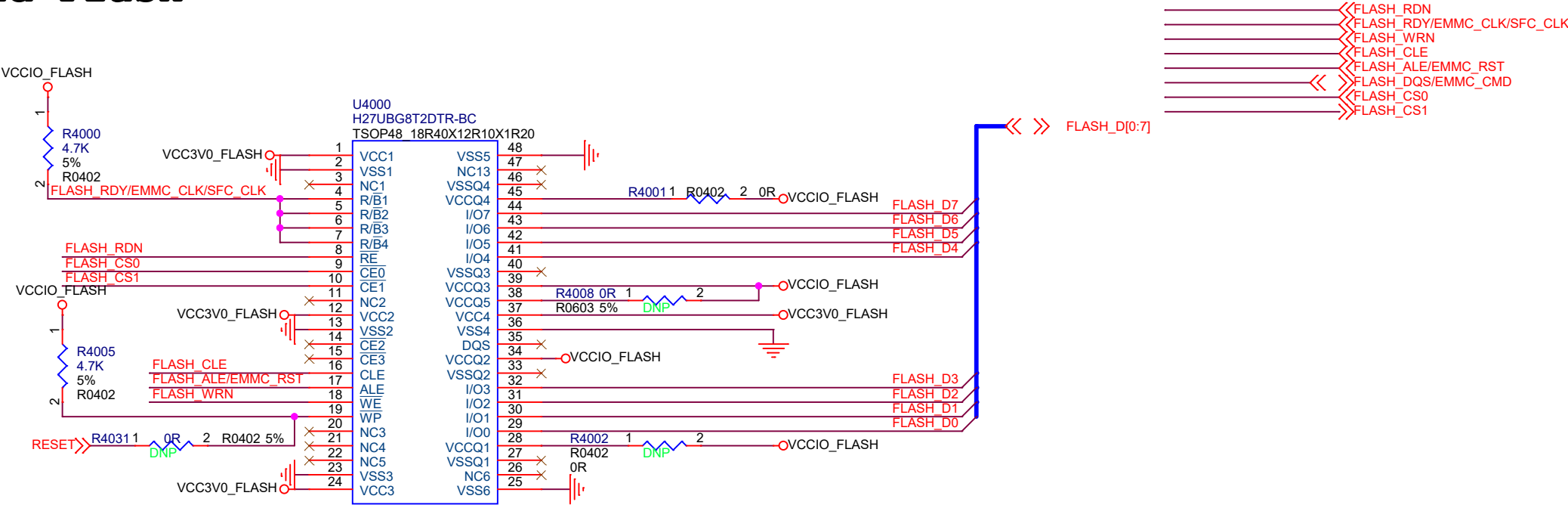


Note:
Short two TP points to Enter Maskrom Mode.

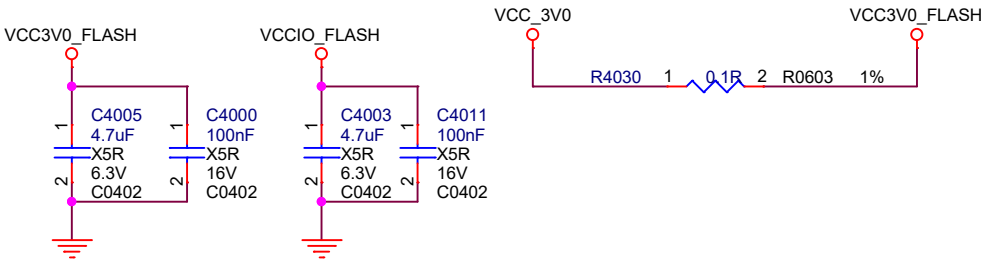
Remind: Refer to the latest AVL for parts selection.

 瑞芯微电子		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	42.Flash-SPI Flash		
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Nand Flash



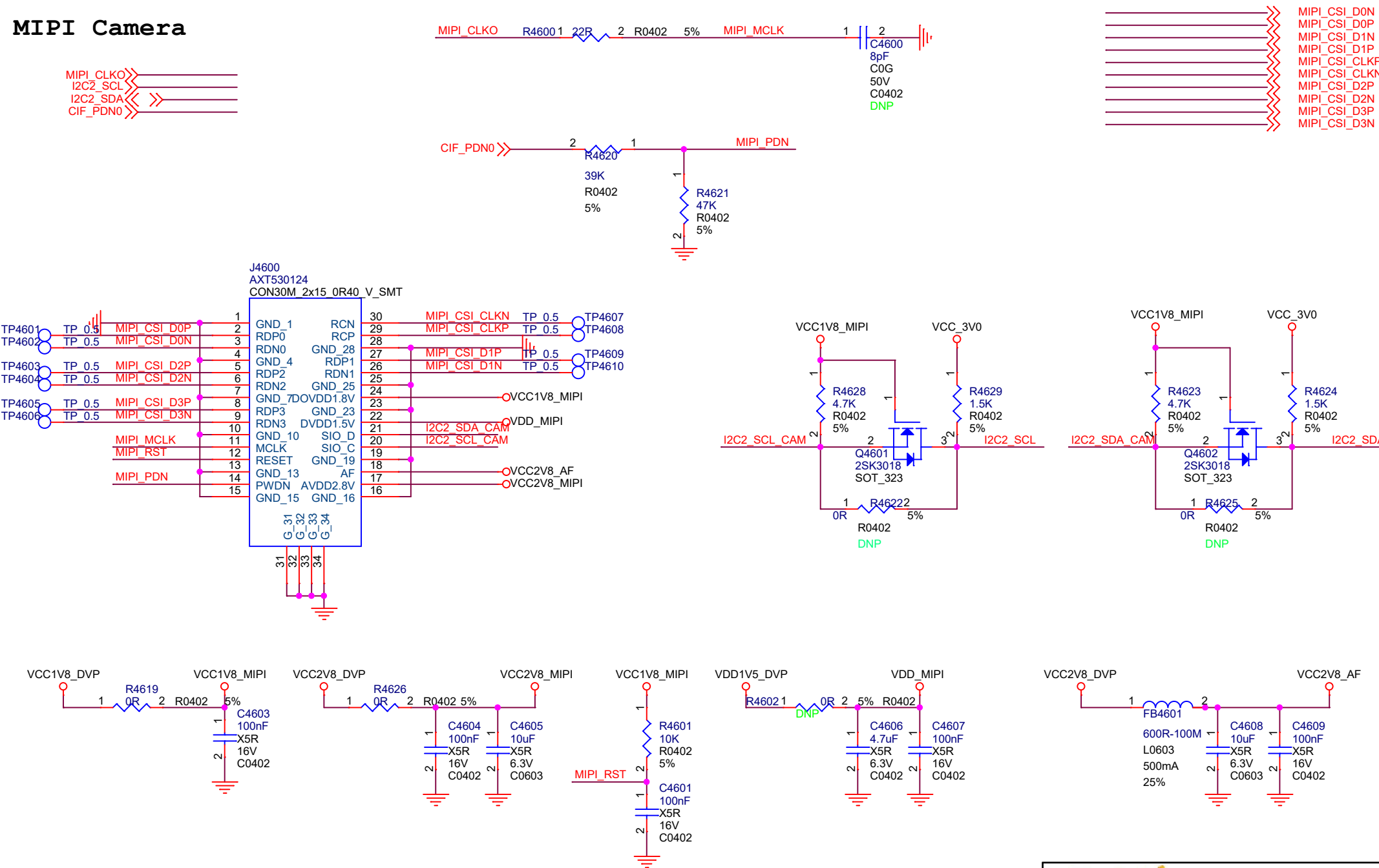
Note: if use toshiba and sandisk DDR mode,
VCCQ1 and VCCQ4 must be connected to VCC_IO。



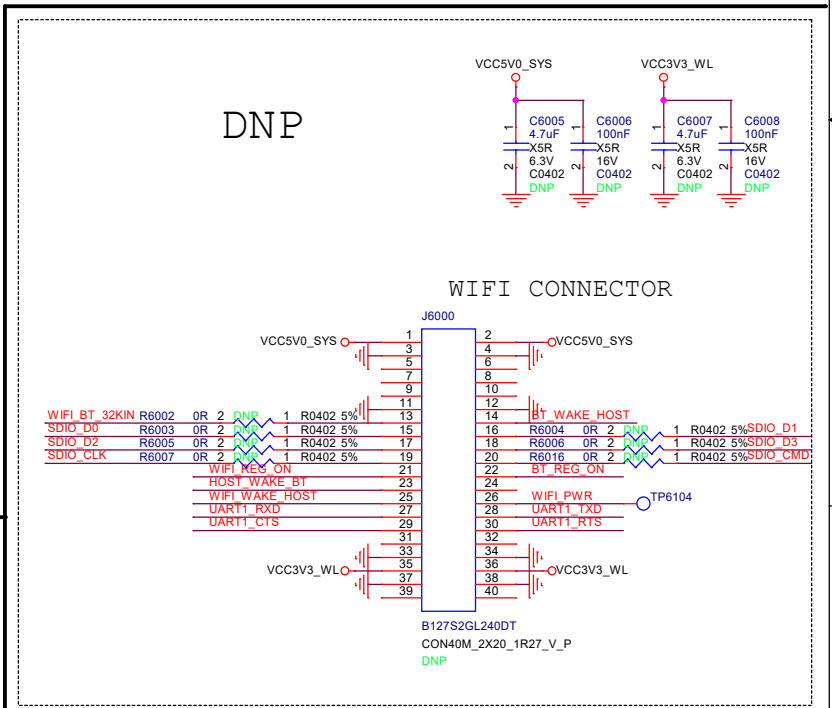
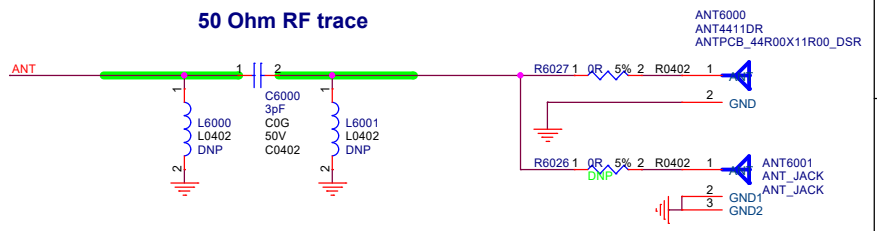
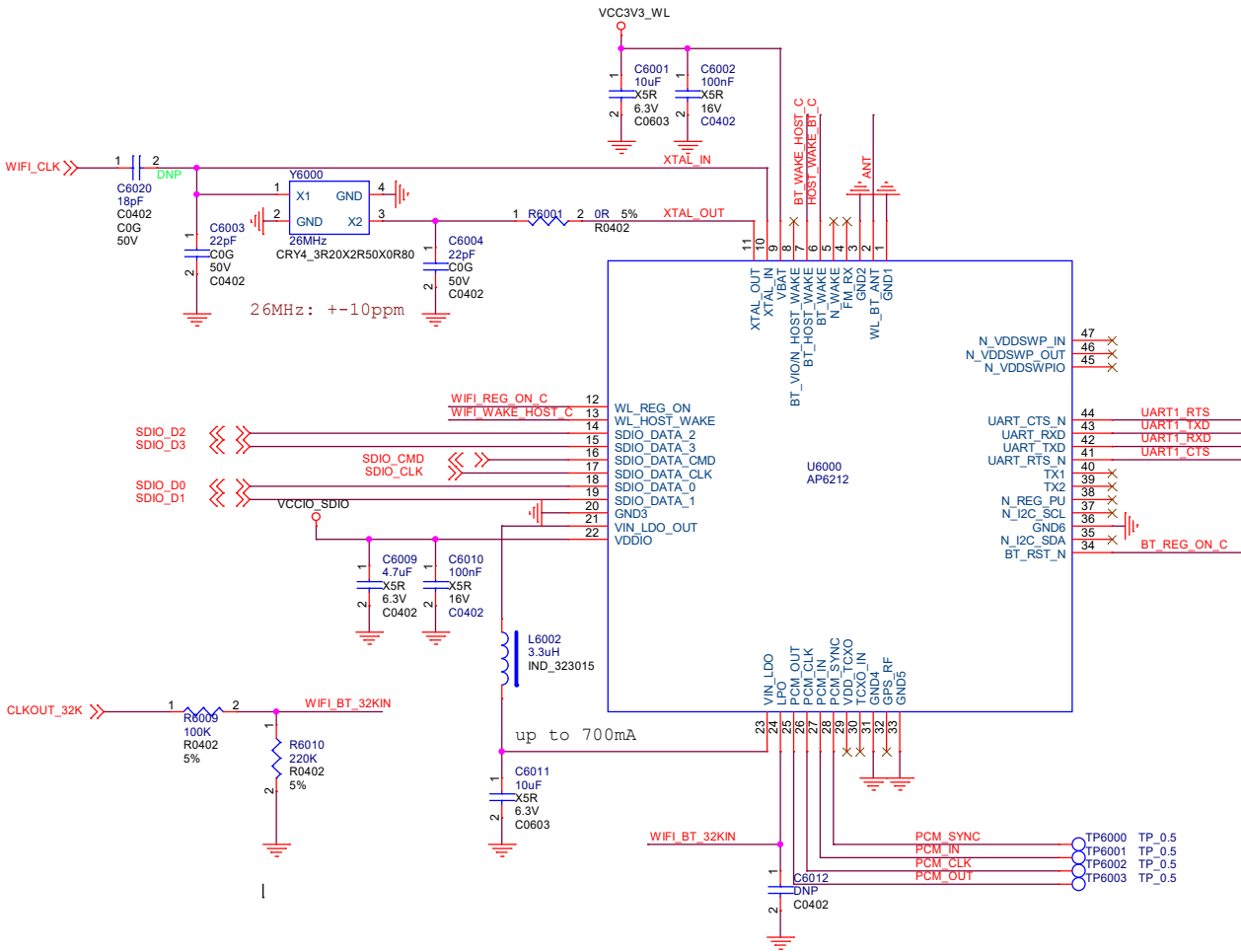
Remind: Refer to the latest AVL for parts selection.

 瑞芯微电子		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	40.Flash-Nand Flash		
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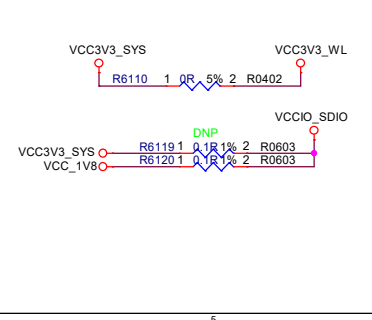
MIPI Camera



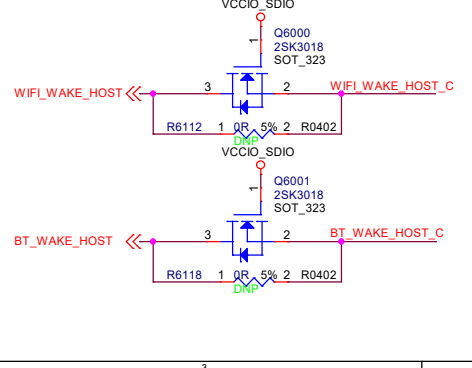
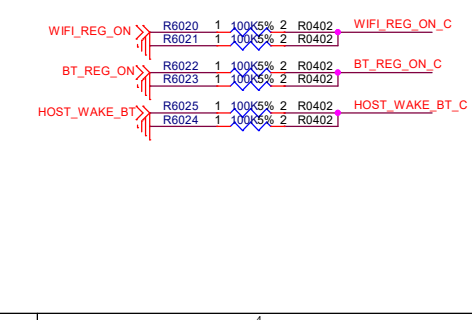
WIFI/BT MODULE

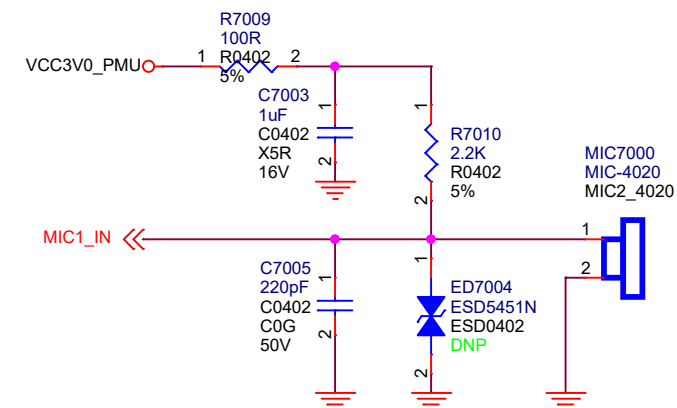
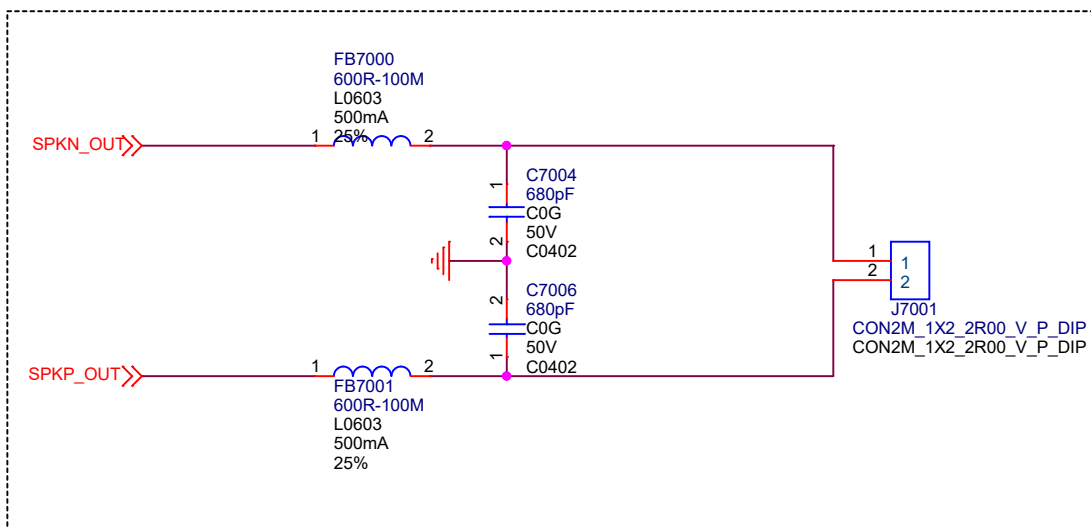
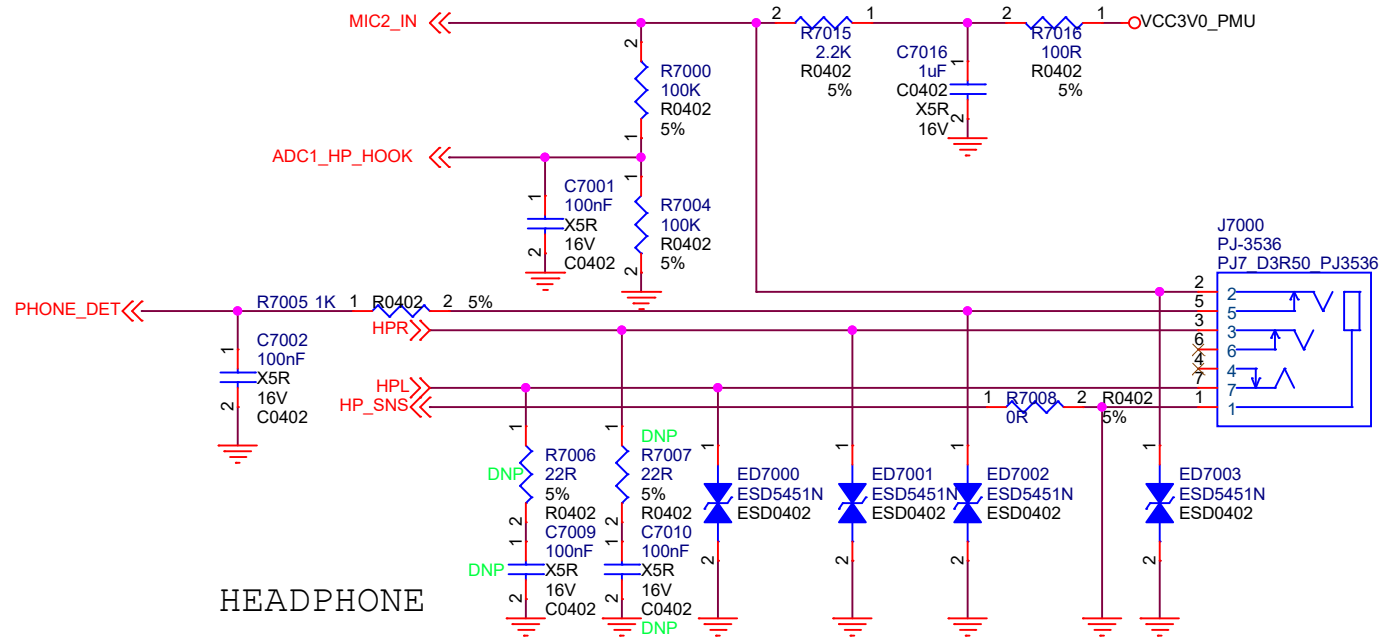


Module Power



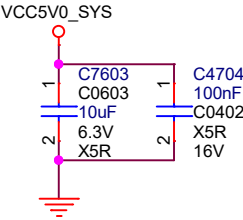
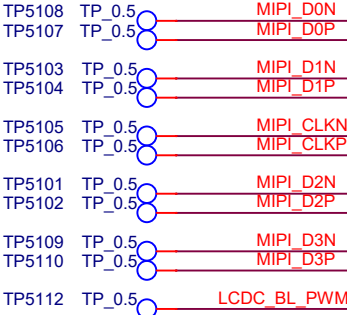
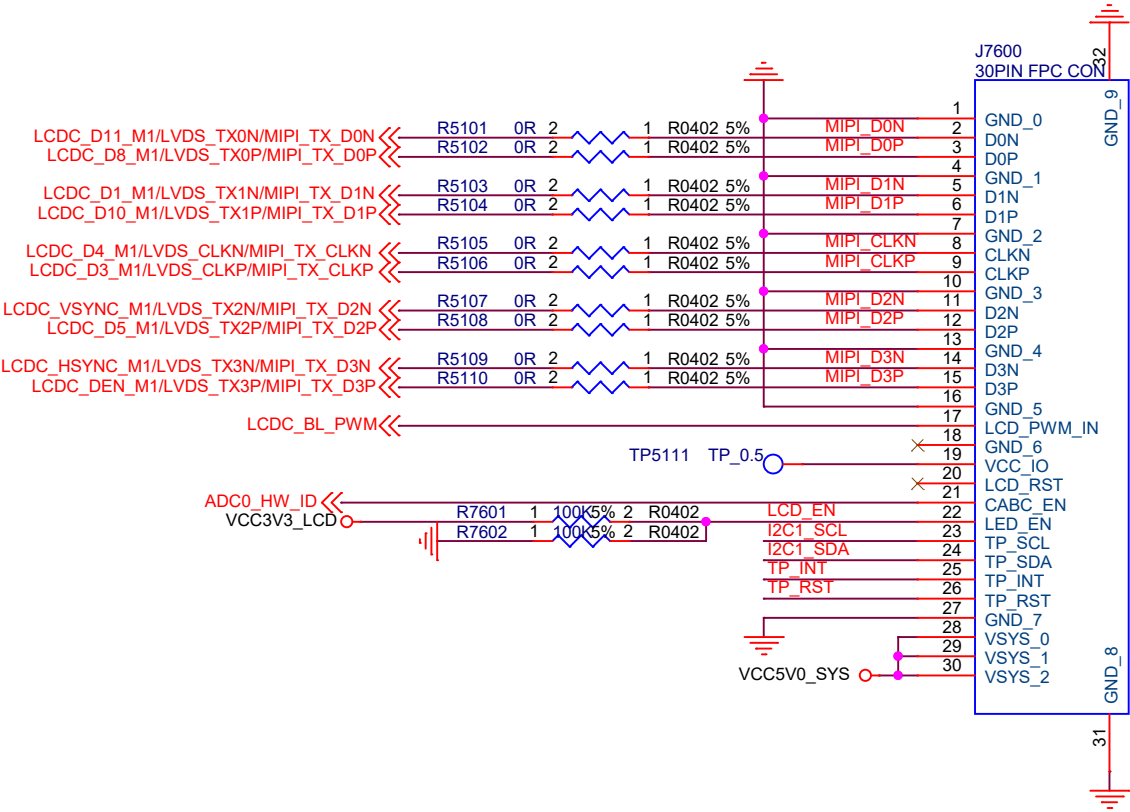
Level Shift





 瑞芯微电子		Fuzhou Rockchip Electronics	
Project:	PX30		
File:	70.AUDIO		
Date:	Thursday, January 11, 2018	Rev:	V0.1
Designed by:	XIAOHF	Sheet:	24 of 35

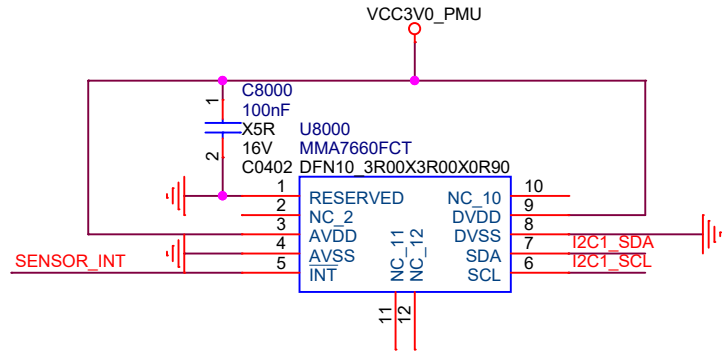
LCM MIPI Connector



<< I2C1_SDA
>> I2C1_SCL

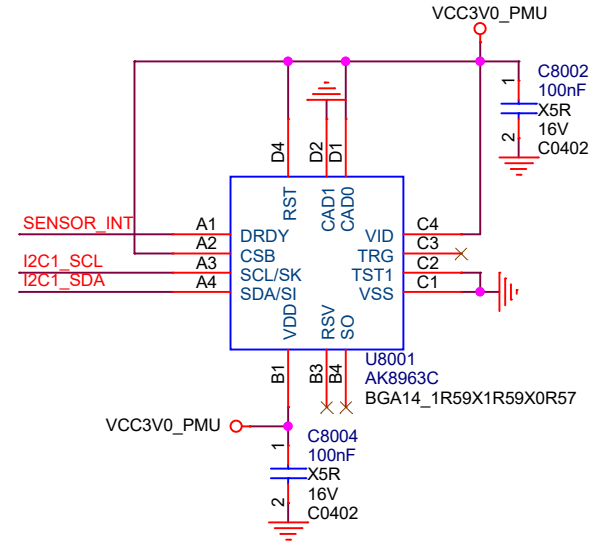
<< SENSOR_INT

G-sensor



Compass

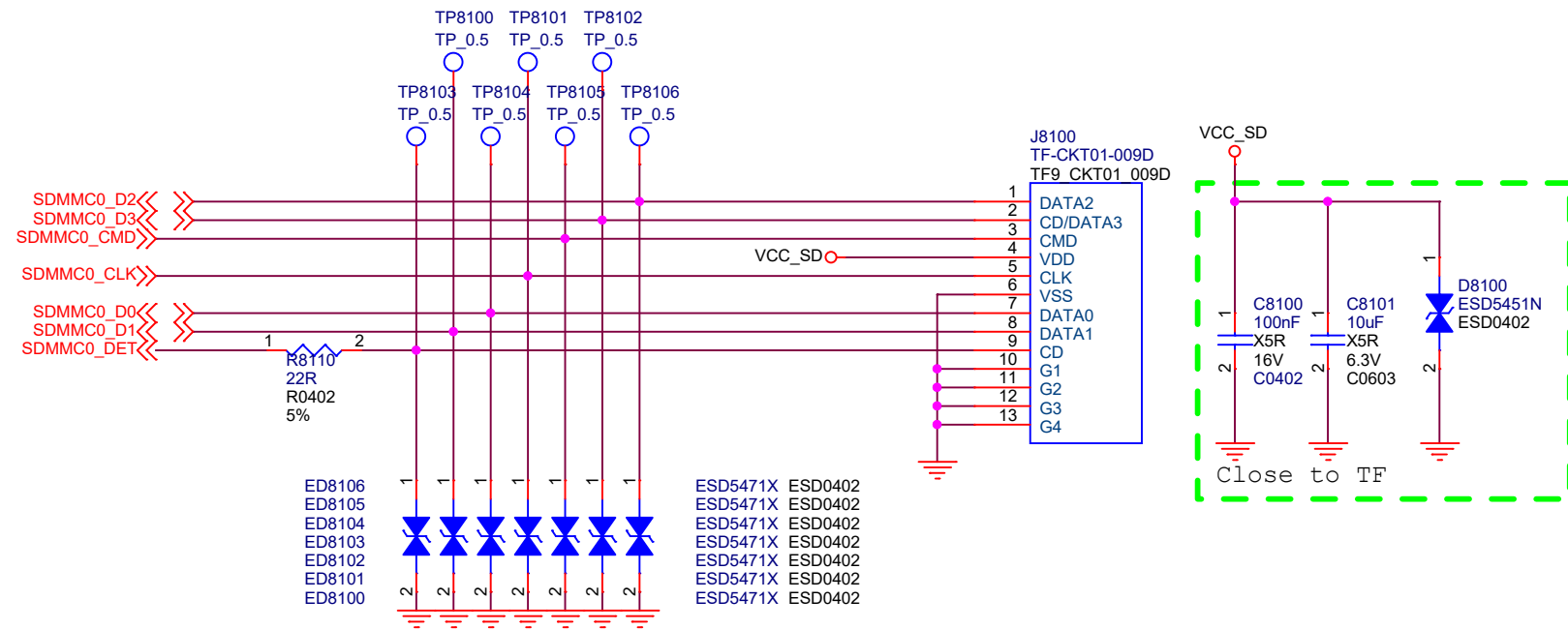
Note:
The first pin of AK8963C must be place on the lower left corner of PCB.

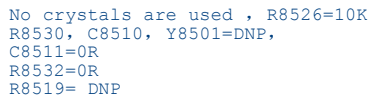
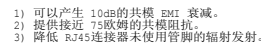
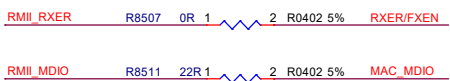


Fuzhou Rockchip Electronics

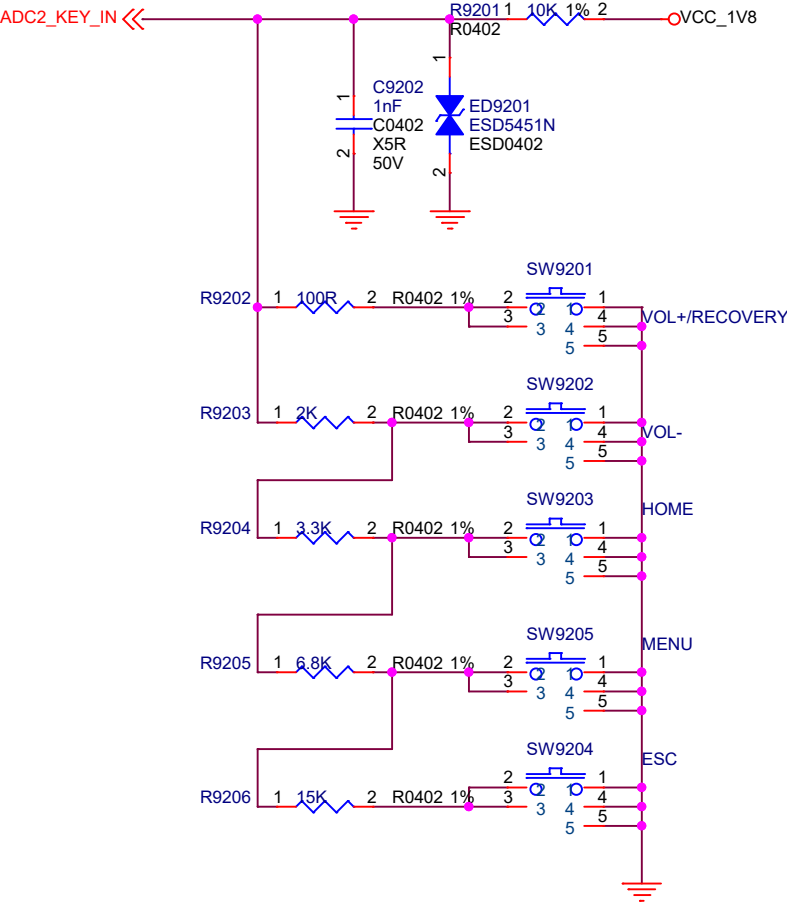
Project:	PX30		
File:	80.Sensor		
Date:	Thursday, January 11, 2018	Rev:	V0.1
Designed by:	XIAOHF	Sheet:	26 of 35

TF Card

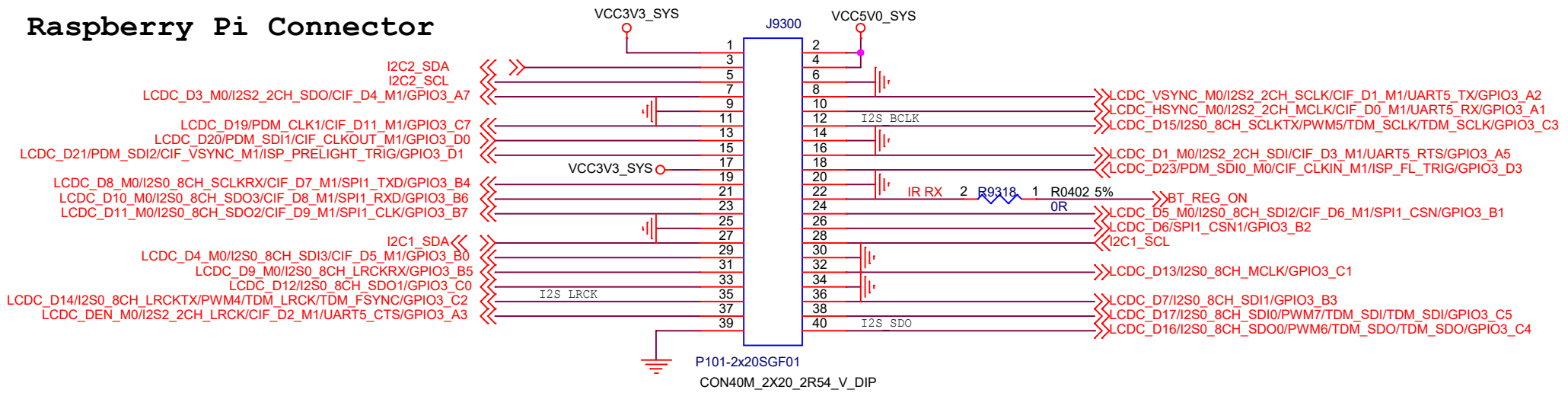




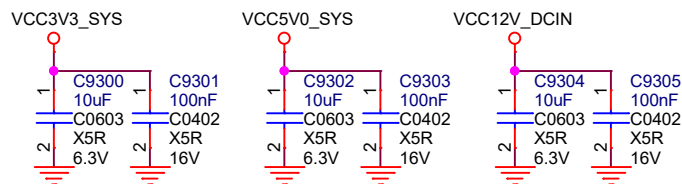
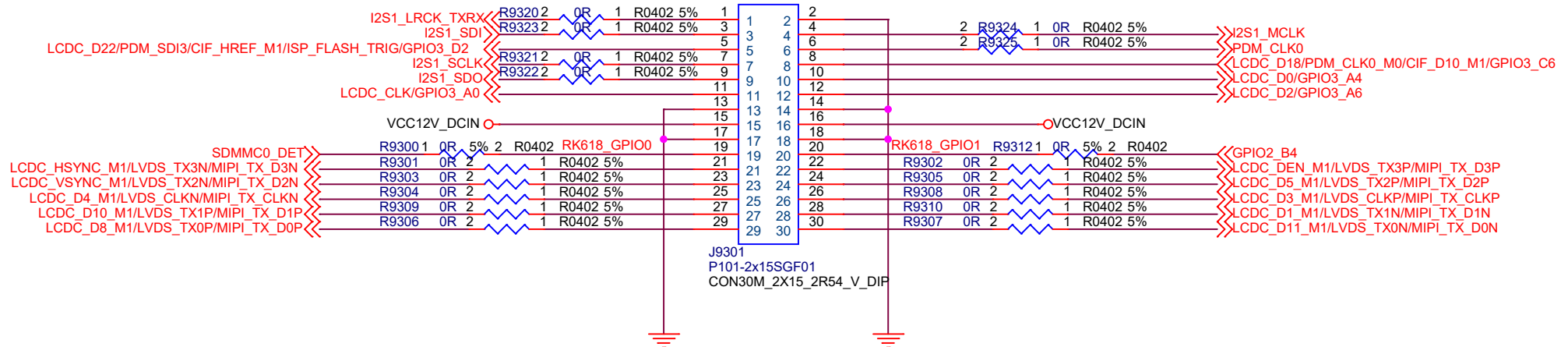
KEY BAORD



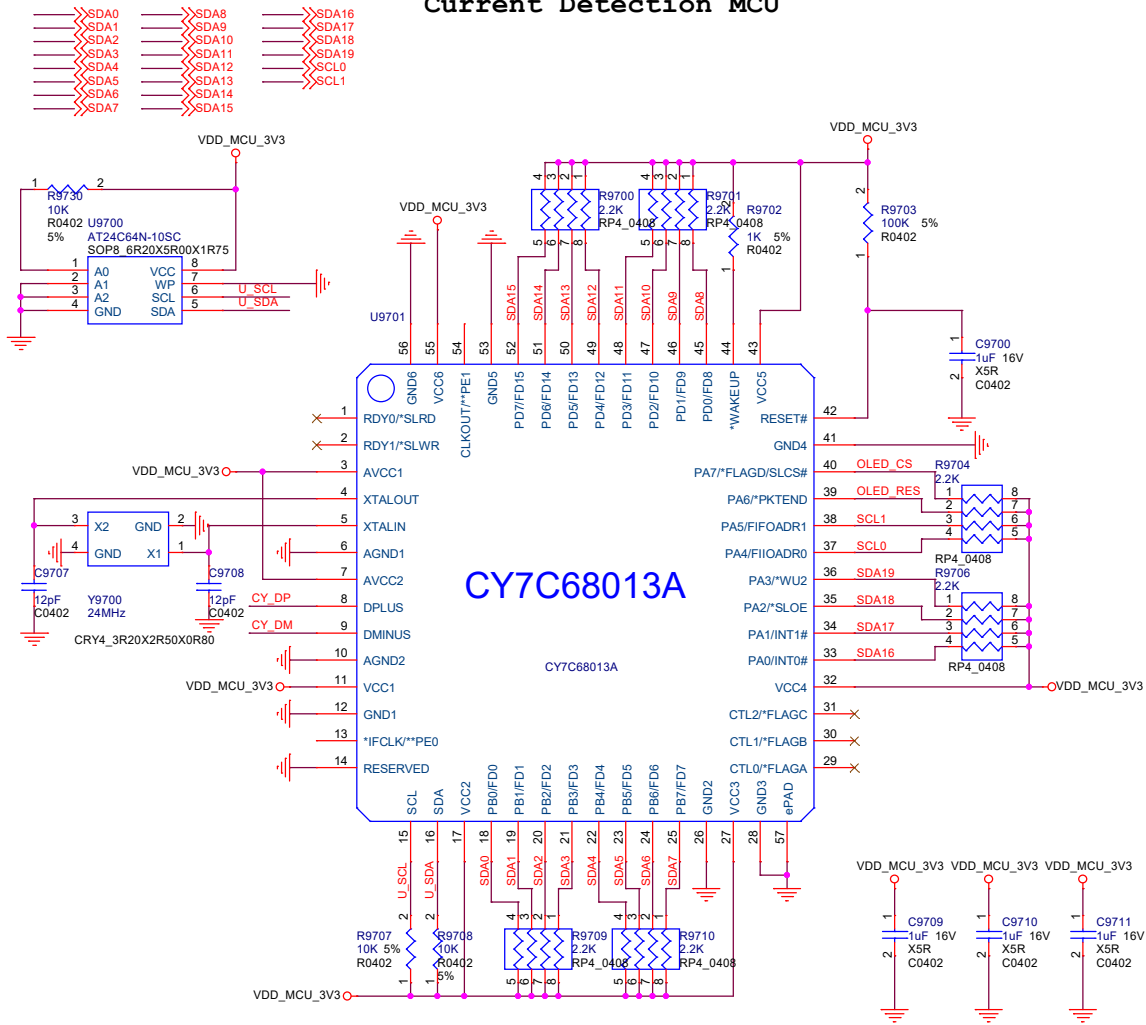
Raspberry Pi Connector



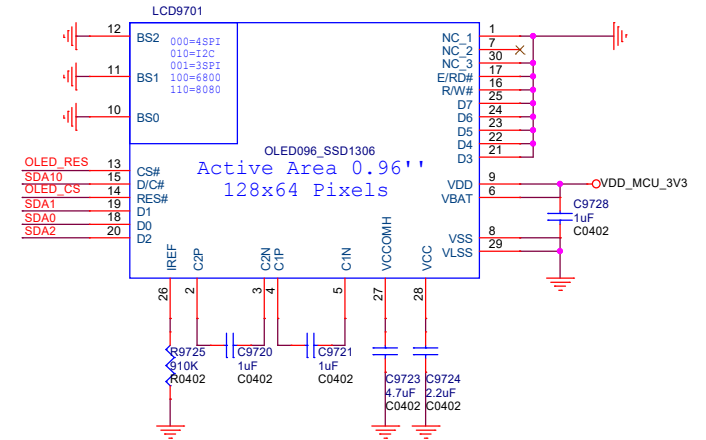
RK616 Connector



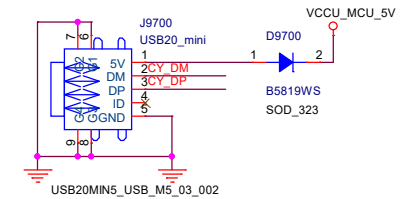
Current Detection MCU



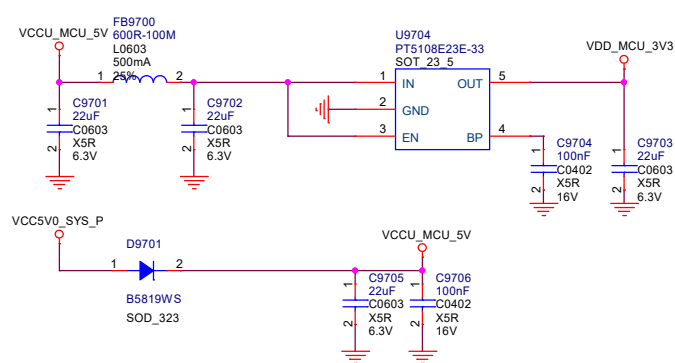
OLED



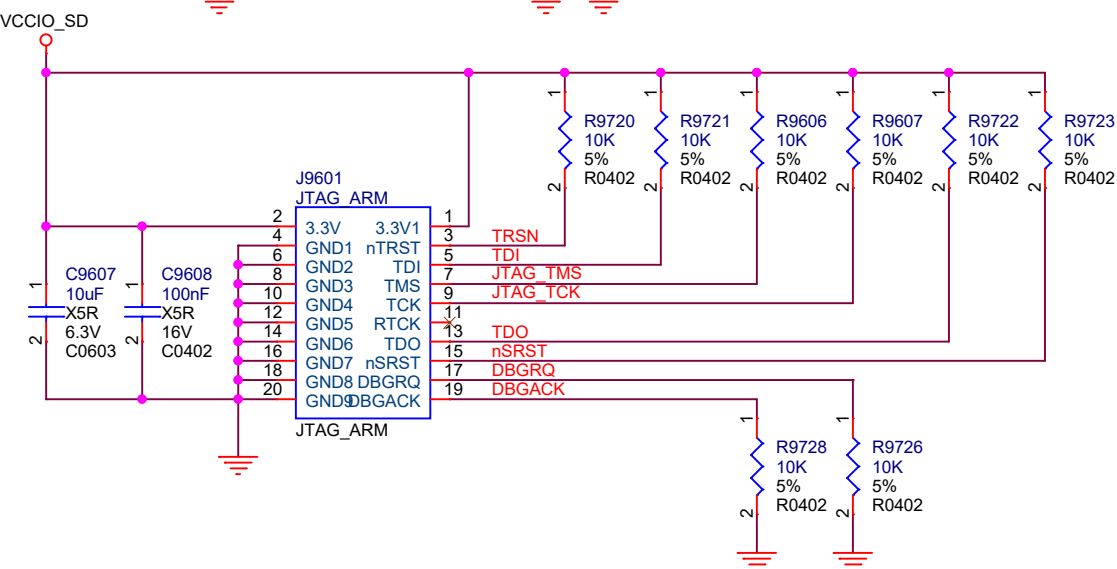
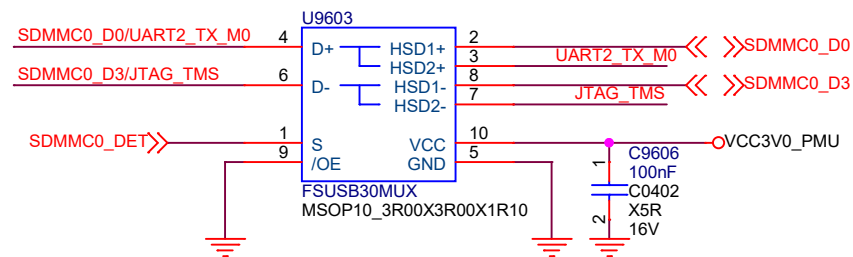
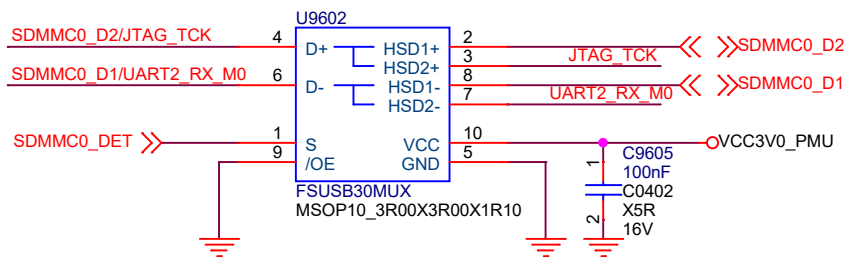
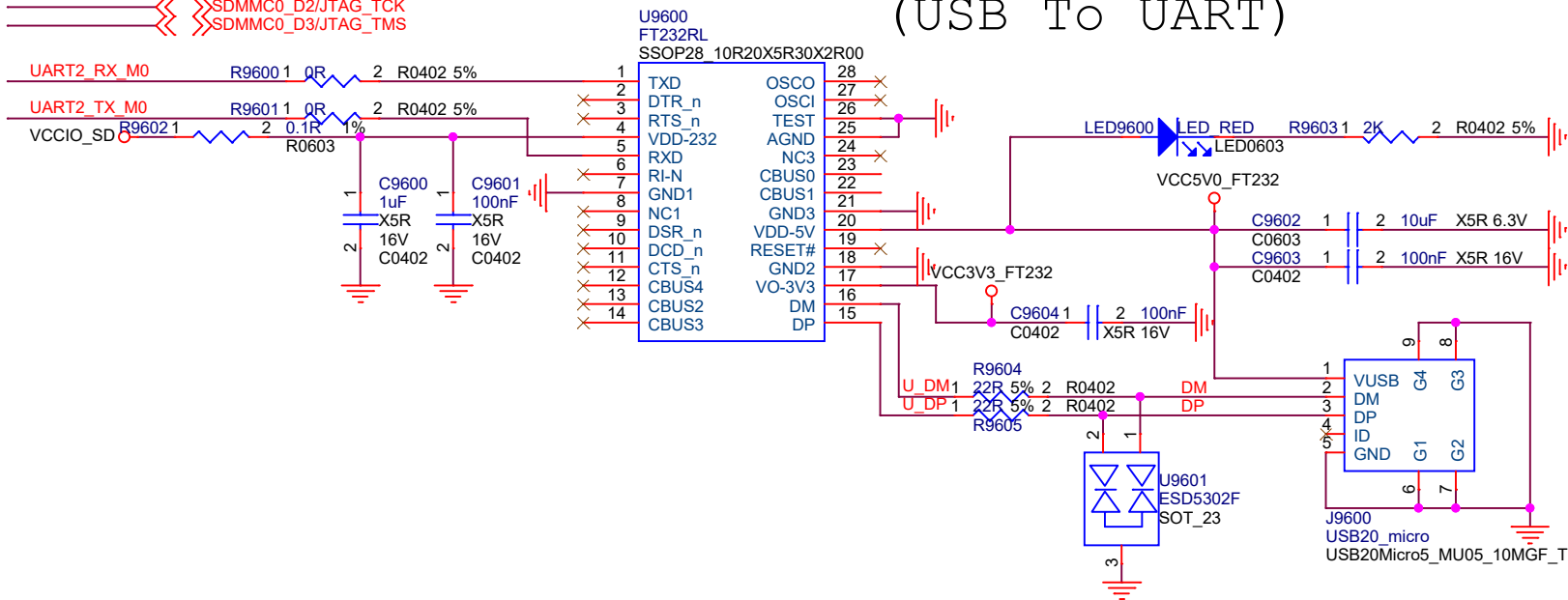
USB Port



Power

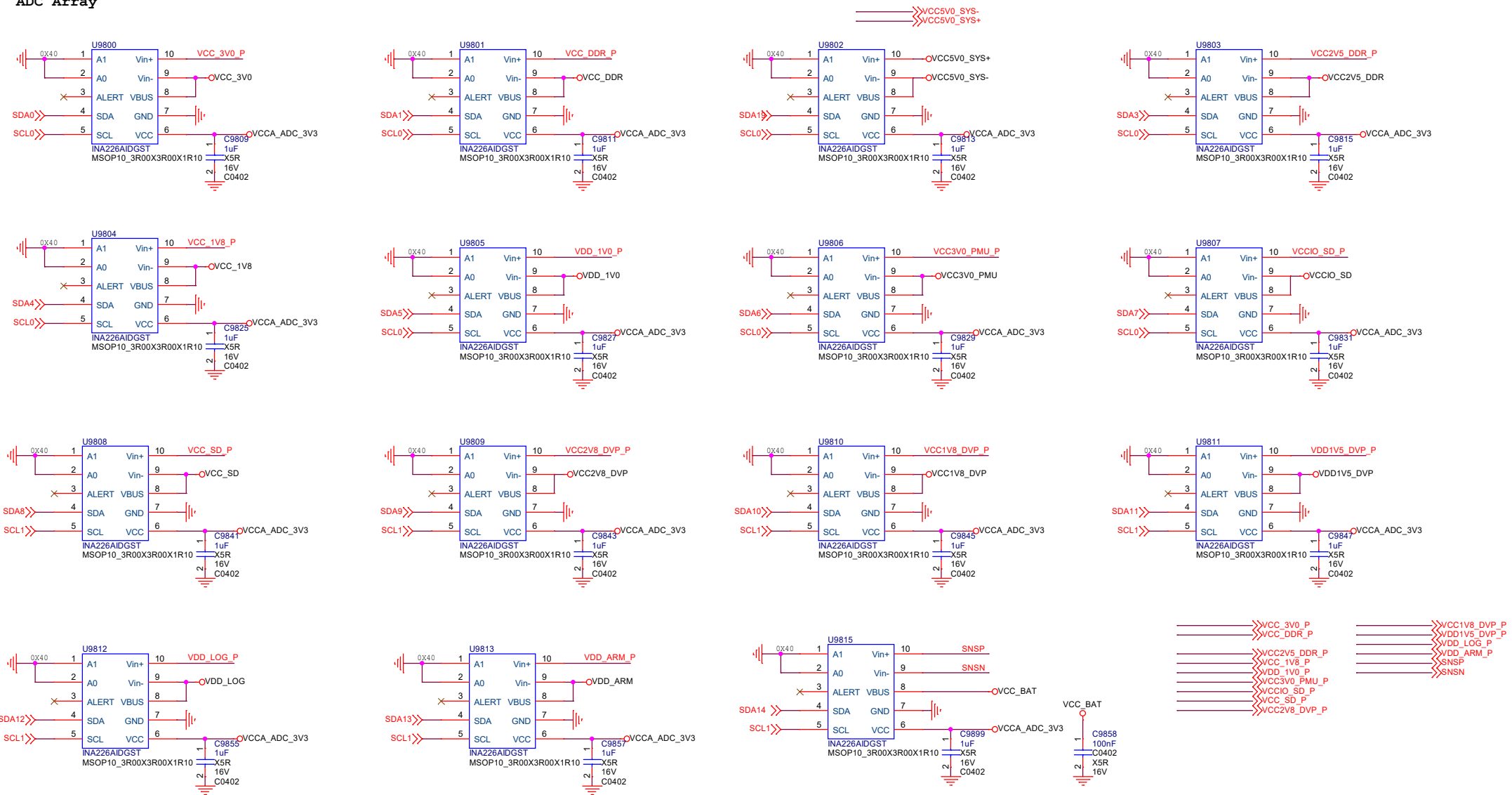


SDMMC0_D1/UART2_RX_M0
SDMMC0_D0/UART2_TX_M0
SDMMC0_D2/JTAG_TCK
SDMMC0_D3/JTAG_TMS



S	OE	Function
X	H	Disconnect
L	L	D+, D- = HSD _{1n}
H	L	D+, D- = HSD _{2n}

ADC Array



ADC Power

